# **MP5475**



Fully Integrated, 12V, 6A, Quad-Buck PMIC with I<sup>2</sup>C, Telemetry, and Flexible System Configurations

#### DESCRIPTION

The MP5475 is a complete power management IC (PMIC) that integrates four high efficiency step-down DC/DC converters and a flexible logic interface.

The integrated DC/DC converters provide constant-on-time (COT) control to achieve fast transient response. In addition, the 1MHz switching frequency (fsw) minimizes the external inductor and capacitor size. Full protection features include under-voltage lockout (UVLO), over-current protection (OCP), under-voltage protection (UVP), and thermal shutdown.

The output voltage ( $V_{OUTx}$ ) (where x = A, B, C, or D) can be adjusted via the  $I^2C$  bus, or it can be preset by the multiple-time programmable (MTP) memory function. The power on/off sequence can also be configured by the MTP, or it can be controlled online via the  $I^2C$ .

The first two rails or the last two rails can work in either independent mode or parallel mode, which can be configured via the MTP. The currentsharing function is implemented in parallel mode.

The MP5475 requires a minimal number of external components, and it is available in a space-saving QFN-35 (5mmx5mm) package.

#### **FEATURES**

- Wide 3V to 16V Input Voltage  $(V_{INx})$  (where x = A, B, C, or D) Range
- Adaptive Constant-On-Time (COT) Control for Ultra-Fast Transient Response
- Four High-Efficiency Step-Down Converters:
  - Buck A: 6A, 15mΩ/5mΩ DC/DC Converter
  - Buck B: 6A, 15mΩ/5mΩ DC/DC Converter
  - Buck C: 6A, 15mΩ/5mΩ DC/DC Converter
  - o Buck D: 6A,  $15m\Omega/5m\Omega$  DC/DC Converter

#### FEATURES (continued)

- Buck A/B and Buck C/D Support Up to 12A of Continuous Current in Dual-Phase Mode
- 2 x 50mA Low-Dropout (LDO) Regulators
- Differential Output Voltage (V<sub>OUTx</sub>) (where x = A, B, C, or D) Remote Sense
- I<sup>2</sup>C Slave Address Configurable via the Multiple-Time Programmable (MTP) Memory
- I<sup>2</sup>C-Configurable, 0.3V to 2.048V Reference Voltage (V<sub>REF</sub>) in 2mV Steps with Slew Rate Control
- Configurable 500kHz to 2MHz Switching Frequency (f<sub>SW</sub>)
- Open-Drain Power Good (PG) Indication and General Status Interrupt
- MTP-Configurable Soft-Start (SS)/Soft Shutdown and Delay
- Selectable Pulse-Frequency Modulation (PFM)/Pulse-Width Modulation (PWM) Mode, Adjustable Frequency, and Current Limit via the I<sup>2</sup>C
- Pre-Biased Start-Up
- Over-Current Protection (OCP), Under-Voltage Lockout (UVLO), Under-Voltage Protection (UVP), Over-Voltage Protection (OVP), and Thermal Shutdown Protection
- Available in a QFN-35 (5mmx5mm)
   Package

---- MPL

Optimized Performance with MPS Inductor MPL4020 Series

#### **APPLICATIONS**

- Storage and Networking
- Enterprise Solid-State Drives (SSDs)
- General Enterprise Applications

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## **TYPICAL APPLICATIONS**

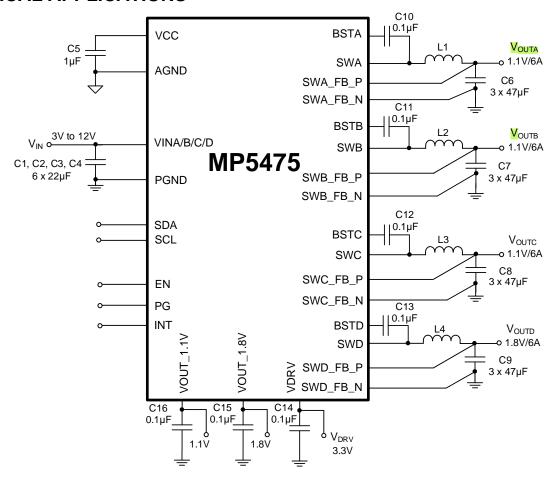


Figure 1: Typical Application (Buck A and Buck B in Single-Phase Regulator Mode)



# **TYPICAL APPLICATIONS** (continued)

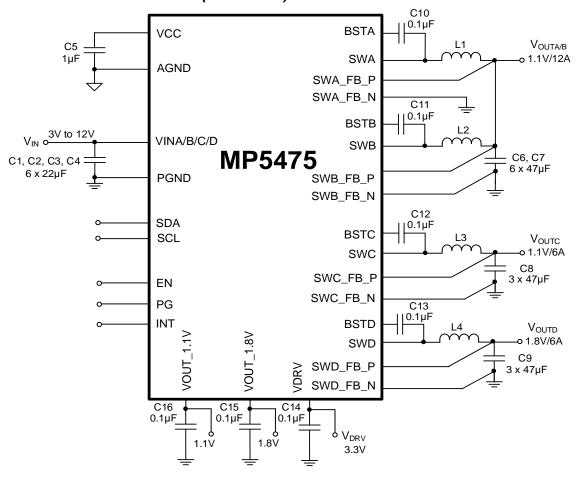
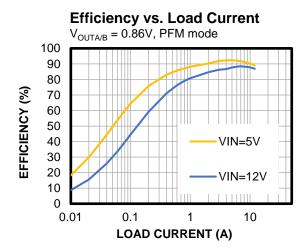
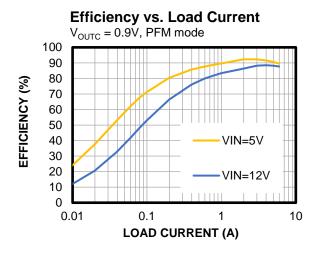


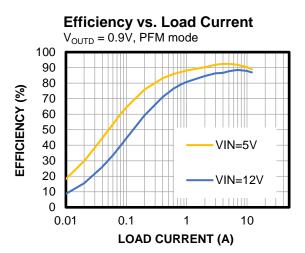
Figure 2: Typical Application (Buck A and Buck B in Dual-Phase Regulator Mode)



# **TYPICAL APPLICATIONS** (continued)









# **DEFAULT MULTIPLE-TIME PROGRAMMABLE (MTP) SELECTION**

OTP Items	Buck A	Buck B	Buck C	Buck D
Output voltage (Vouт)	1.1V	1.1V	1.1V	1.8V
Initial on/off	On	On	On	On
Mode	Forced PWM	Forced PWM	Forced PWM	Forced PWM
Start-up delay/time slot number	15ms/3	10ms/2	5ms/1	0ms/0
Switching frequency (fsw)	750kHz	750kHz	750kHz	750kHz
Low-power mode (LPM)	Disabled	Disabled	Disabled	Disabled
Active voltage positioning (AVP) mode	Disa	abled	Disabled	
Buck parallel mode	Unpar	alleled	Unpar	alleled
Software initial I <sup>2</sup> C slave address		0x	60	
V <sub>IN</sub> under-voltage lockout (UVLO) rising threshold	2.85V			
Multiple-time programmable (MTP) configuration code	0000			



#### ORDERING INFORMATION

Part Number*	Package	Top Marking	MSL Rating
MP5475GU-xxxx**	OFN 25 (FmmyFmm)	Coo Polow	4
MP5475GU-0000	QFN-35 (5mmx5mm)	See Below	ı

<sup>\*</sup> For Tape & Reel, add suffix -Z (e.g. MP5475GU-xxxx-Z).

# TOP MARKING MPSYYWW MP5475 LLLLLLL

MPS: MPS prefix YY: Year code WW: Week code MP5475: part number LLLLLL: Lot number

### **EVALUATION KIT (EVKT-5475)**

EVKT-5475 kit contents (items below can be ordered separately):

#	Part Number	Item	Quantity
1	EVL5475-U-00B	MP5475 evaluation board	1
2	EVKT-USBI2C-02	Includes one USB-to-I <sup>2</sup> C communication interface device, one USB cable, and one ribbon cable	1
3	MP5475GU-0018	MP5475 IC (can be used for MTP configuration)	2
4	Online resources	Includes the datasheet, user guide, product brief, and GUI	1

#### Order directly from MonolithicPower.com or our distributors.

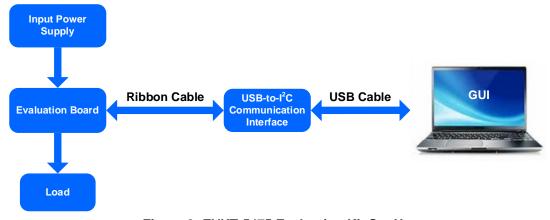


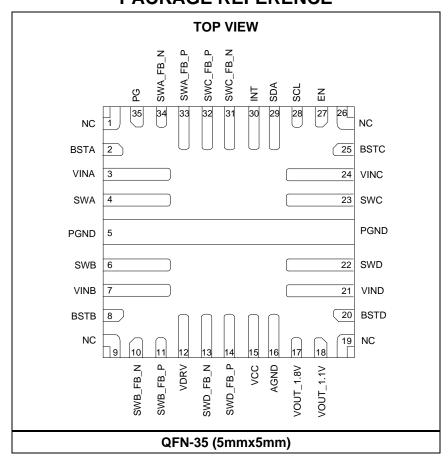
Figure 3: EVKT-5475 Evaluation Kit Set-Up

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<sup>\*\* &</sup>quot;xxxx" is the configuration code identifier for the register setting stored in the multiple-time programmable (MTP) memory. The default code is "0000". Each "x" can be a hexadecimal value between 0 and F. Work with an MPS FAE to create this unique number, even if ordering the "0000" code. The MP5475GU-0000 is the default version.



## **PACKAGE REFERENCE**



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## **PIN FUNCTIONS**

	10110113	
Pin#	Name	Description
1, 9, 19, 26	NC	No connection.
2	BSTA	<b>Buck converter A (buck A) bootstrap.</b> Connect a capacitor between the SWA and BSTA pins to form a floating supply across buck A's high-side (HS) switch driver.
3	VINA	<b>Supply voltage input for buck A.</b> A ceramic capacitor is required to decouple the input rail. Connect the VINA pin using a wide PCB trace. VINA, VINB, VINC, and VIND must be connected to the same bus voltage.
4	SWA	Buck A switch output. Connect the SWA pin using a wide PCB trace.
5	PGND	<b>Power ground.</b> The PGND pin requires special consideration during PCB layout. Connect the PGND pin with copper traces and vias.
6	SWB	<b>Buck converter B (buck B) switch output.</b> Connect the SWB pin using a wide PCB trace.
7	VINB	<b>Supply voltage input for buck B.</b> A ceramic capacitor is required to decouple the input rail. Connect the VINB pin using a wide PCB trace.
8	BSTB	<b>Buck B bootstrap.</b> Connect a capacitor between the SWB and BSTB pins to form a floating supply across buck B's HS switch driver.
10	SWB_FB_N	<b>Negative feedback for buck B.</b> Kelvin connect the SWB_FB_N pin to the ground node of the output capacitor (C <sub>OUT</sub> ) on buck B.
11	SWB_FB_P	<b>Positive feedback for buck B.</b> Connect buck B's output to the SWB_FB_P pin directly.
12	VDRV	<b>3.3V supply input to the power management IC (PMIC).</b> Connect a 3.3V power supply to the VDRV pin. If there is no external 3.3V power supply, connect this pin to VCC.
13	SWD_FB_N	Remote sense ground for buck converter D (buck D). Kelvin connect the SWD_FB_N pin to the ground node of Cout on buck D.
14	SWD_FB_P	Positive feedback for buck D. Connect buck D's output to the SWD_FB_P pin directly.
15	VCC	Internal 3.3V low-dropout (LDO) output. The driver and control circuits are powered from the VCC pin voltage ( $V_{CC}$ ). Decouple VCC with a 1 $\mu$ F ceramic capacitor placed as close to the pin as possible. Ceramic capacitors with X7R or X5R dielectrics are recommended due to their stable temperature characteristics.
16	AGND	Analog ground. Connect AGND to the power ground pin.
17	VOUT_1.8V	1.8V LDO output from the PMIC.
18	VOUT_1.1V	1.1V LDO output from the PMIC.
20	BSTD	<b>Buck D bootstrap.</b> Connect a capacitor between SWD and BSTD pins to form a floating supply across buck D's HS switch driver.
21	VIND	<b>Supply voltage input for buck D.</b> A ceramic capacitor is required to decouple the input rail. Connect the VIND pin using a wide PCB trace.
22	SWD	Buck D switch output. Connect the SWD pin using a wide PCB trace.
23	SWC	<b>Buck converter C (buck C) switch output.</b> Connect the SWC pin using a wide PCB trace.
24	VINC	<b>Supply voltage input for buck C.</b> A ceramic capacitor is required to decouple the input rail. Connect the VINC pin using a wide PCB trace.
25	BSTC	<b>Buck C bootstrap.</b> Connect a capacitor between the SWC and BSTC pins to form a floating supply across the buck C's HS switch.
27	EN	<b>Enable control.</b> Apply a logic low-to-high transition to the EN pin to enable the PMIC.



#### PIN FUNCTIONS (continued)

Pin#	Name	Description
28	SCL	I <sup>2</sup> C bus clock.
29	SDA	I <sup>2</sup> C bus data.
30	INT	<b>General status interrupt.</b> The INT pin is an open-drain output. The MP5475 asserts INT low to communicate any single (or more) critical event(s) to the host. INT remains asserted until the appropriate registers are explicitly cleared, or the MP5475 is reset.
31	SWC_FB_N	Remote-sense ground for buck C. Kelvin connect the SWC_FB_N pin to the ground node of Cout on buck C.
32	SWC_FB_P	Positive feedback for buck C. Connect buck C's output to the SWC_FB_P pin directly.
33	SWA_FB_P	<b>Positive feedback for buck A.</b> Connect buck A's output to the SWA_FB_P pin directly. SWA_FB_P is the feedback input of the dual-phase buck when buck A and buck B are set to dual-phase interleaving mode.
34	SWA_FB_N	Remote-sense ground of buck A and buck B. Kelvin connect the SWA_FB_N pin to ground node of Cout on buck A and buck B.
35	PG	<b>Open-drain power good (PG) output.</b> Pull the PG pin low when any enabled regulator falls below its under-voltage (UV) threshold. Pull PG low when all regulators are disabled.

#### ABSOLUTE MAXIMUM RATINGS (1)

Supply voltage (V <sub>INx</sub> )	<mark>18V</mark>
V <sub>SWx_DC</sub>	$0.3V \text{ to } V_{IN} + 0.3V$
$V_{BSTx}$	$V_{SW} + 4V$
V <sub>CC</sub>	4.3V
All other pins	0.3V to VCC
Junction temperature (T <sub>J</sub> )	170°C
Lead temperature	260°C
Storage temperature	

#### ESD Ratings (2)

Human body model (HB	3M)	±2000V
Charged-device model (	(CDM).	±750V

#### Recommended Operating Conditions (3)

Supply voltage (	$V_{INx}$ ) (x = A, B, C, or D)
	3V to 16V
V <sub>IN_DC</sub> - V <sub>SW_DC</sub> (4)	0.3V to V <sub>IN</sub> + 0.3V
V <sub>SW_DC</sub> (4)	0.3V to V <sub>IN</sub> + 0.3V
Output voltage (\	$V_{OUTx}$ ) (x = A, B, C, or D)
	Refer to the I <sup>2</sup> C setting

Operating junction temp (T<sub>J</sub>).... -40°C to +125°C

## Thermal Resistance $\theta_{JA}$ $\theta_{JC}$

QFN-35 (5mmx5mm)			
EV5475-U-00A (5)	25	2.5	°C/W
JESD51-7 (6)	29	.18.1 .	°C/W

#### Notes:

- 1) Exceeding these ratings may damage the device.
- 2) HBM, per JEDEC specification JESD22-A114; CDM, per JEDEC specification JESD22-C101, AEC specification AECQ100-011. JEDEC document JEP155 states that 500V HBM allows safe manufacturing with a standard ESD control process. JEDEC document JEP157 states that 250V CDM allows safe manufacturing with a standard ESD control process.
- The device is not guaranteed to function outside of its operating conditions.
- 4) The voltage rating can be between -3V and +23V for a period of 25ns or shorter with a maximum repetition rate of 1000kHz when  $V_{IN}$  is 16V.
- 5) Measured on the EV5475-U-00A, 4-layer PCB.
- 6) Measured on a JESD51-7, 4-layer PCB. The value of θ<sub>JA</sub> given in this table is only valid for comparison with other packages and cannot be used for design purposes. These values were calculated in accordance with JESD51-7, and simulated on a specified JEDEC board. They do not represent the performance obtained in an actual application.



## **ELECTRICAL CHARACTERISTICS**

 $V_{IN} = 12V$ ,  $T_J = -40$ °C to +125°C, typical values are tested at  $T_J = 25$ °C, unless otherwise noted.

Parameter	Symbol	Condition	Min	Тур	Max	Units
Default switching frequency	$f_{\sf SW}$		850	1000	1150	kHz
EN rising threshold	V <sub>EN</sub>		1.21	1.25	1.29	V
EN hysteresis	V <sub>EN_HYS</sub>			220		mV
EN pull-down resistor	R <sub>EN</sub>			2.2		МΩ
Step-Down Regulators						•
V <sub>INx</sub> under-voltage lockout (UVLO) rising threshold (where x = A, B, C, or D)	V <sub>INx_UVLO_R</sub>		2.75	2.85	2.95	V
V <sub>INx</sub> UVLO hysteresis	V <sub>INx_UVLO_</sub>			250		mV
$V_{\text{INx}}$ over-voltage (OV) rising threshold			16	16.6	17.5	V
V <sub>INx</sub> OV hysteresis				650		mV
	$V_{FB1}$	Default output of buck converter A (buck A), T <sub>J</sub> = 25°C	-1%	1.1	+1%	V
Feedback (FB) voltage	$V_{\text{FB2}}$	Default output of buck converter B (buck B), T <sub>J</sub> = 25°C	-1%	1.1	+1%	V
accuracy	$V_{\text{FB3}}$	Default output of buck converter C (buck C), T <sub>J</sub> = 25°C	-1%	1.1	+1%	V
	$V_{FB4}$	Default output of buck converter D (buck D), T <sub>J</sub> = 25°C	-1%	1.8	+1%	V
FB under-voltage (UV) threshold 1 (low to high) (7)		Hiccup entry (FB UV with OC for 50 cycles)		80		% of V <sub>REF</sub>
FB UV threshold 2 (high to low) (7)		Hiccup entry (FB UV with 2.5µs deglitch)		75		% of V <sub>REF</sub>
Buck A, Buck B, Buck C, ar	nd Buck D					
High-side MOSFET (HS-FET) on resistance	R <sub>DS(ON)_</sub> HS1	For buck A/B/C/D		15		mΩ
Low-side MOSFET (LS-FET) on resistance	R <sub>DS(ON)_LS1</sub>	For buck A/B/C/D		5		mΩ
Switch leakage	SW <sub>ILK1</sub>	T <sub>J</sub> = 25°C		0	1	μA
Low-side (LS) current limit (source)	ILS_VALLEY1	Valley limit is independent of the high-side (HS) peak current limit	6	7	8	А
Negative current limit	I <sub>NOCP</sub>	Forced pulse-width modulation (PWM)/OVP discharge		-5		Α
Minimum on time (7)	ton_min1			20		ns
Minimum off time (7)	toff_MIN1			100		ns
Output over-voltage protection (OVP) rising threshold	V <sub>OVP1_H</sub>		117	122	127	% of V <sub>REF</sub>
Output OVP recovery threshold	V <sub>OVP1_L</sub>			110		% of $V_{REF}$
Buck A soft-start time	tss_B1	Default, V <sub>OUT</sub> = 10% to 90%		0.88		ms
Buck B soft-start time	tss_ <sub>B2</sub>	Default, V <sub>OUT</sub> = 10% to 90%		0.88		ms



# **ELECTRICAL CHARACTERISTICS** (continued)

 $V_{IN} = 12V$ ,  $T_J = -40$ °C to +125°C, typical values are tested at  $T_J = 25$ °C, unless otherwise noted.

Parameter	Symbol	Condition	Min	Тур	Max	Units
Buck C soft-start time	t <sub>SS_B3</sub>	Default, V <sub>OUT</sub> = 10% to 90%		0.88		ms
Buck D soft-start time	tss_B4	Default, V <sub>OUT</sub> = 10% to 90%		1.44		ms
Low-Dropout (LDO) Regula	itor		•			
VDRV voltage (V <sub>DRV</sub> ) UVLO rising threshold			2.8	3	3.2	V
V <sub>DRV</sub> UVLO falling threshold			2.6	2.8	3	V
V <sub>DRV</sub> OV rising threshold			3.4	3.6	3.8	V
V <sub>DRV</sub> OV hysteresis				250		mV
50mA, 1.1V Low-Dropout (I	_DO) Regul	ator				
Default output voltage	$V_{1V1}$	I <sub>OUT</sub> = 0A to 20mA, power-on state	-5%	1.1	+5%	V
Current limit	I <sub>LIM_1V1</sub>		50	70		mA
50mA, 1.8V Low-Dropout (I	₋DO) Regul	ator				
Default output voltage	$V_{1V8}$	I <sub>OUT</sub> = 0A to 20mA, power-on state	-5%	1.8	+5%	V
Current limit	I <sub>LIM_1V8</sub>		50	70		mA
Power Good (PG) and Inter	rupt (INT)					
PG UV rising threshold	$V_{PG\_UV\_R}$		86	90	94	% of V <sub>REF</sub>
PG UV falling threshold	V <sub>PG_UV_F</sub>			78		% of V <sub>REF</sub>
PG OV rising threshold	$V_{PG\_OV\_R}$		117	122	127	% of V <sub>REF</sub>
PG OV falling threshold	V <sub>PG_OV_F</sub>			110		% of V <sub>REF</sub>
PG rising delay (7)	tPG_R_DLY			500		μs
PG falling delay (7)	tPG_F_DLY			50		μs
PG output port sink current capability	V <sub>PG_SINK</sub>	Sink 1mA			0.4	V
INT output port sink current capability	V <sub>INT_SINK</sub>	Sink 1mA			0.4	V
VCC Regulator						
VCC voltage	Vcc	Icc = 25mA		3.5		V
VCC voltage regulation	Vcc_rg	Icc = 0mA to 25mA		1		%
Temperature Protection						
Thermal shutdown (7)	T <sub>OTP_R</sub>			150		°C
Thermal hysteresis (7)	T <sub>HYS</sub>			20		°C
I <sup>2</sup> C Signals						
Input high voltage (SDA or SCL)	ViH		1.4			V
Input low voltage (SDA or SCL)	VIL				0.4	V



# I<sup>2</sup>C PORT SIGNAL CHARACTERISTICS (7)

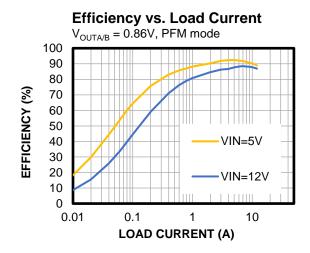
Parameter	Symbol	0 1141	Св = 1	100pF	C <sub>B</sub> = 4	100pF	l lm!ta
		Condition	Min	Max	Min	Max	Units
SCLH and SCL clock frequency	fschl		0	3.4	0	0.4	MHz
Set-up time for a repeated start command	tsu_sta		160		600		ns
Hold time for a (repeated) start command	t <sub>HD_STA</sub>		160		600		ns
Low period of the SCL clock	tLOW		160		1300		ns
High period of the SCL clock	<b>t</b> HIGH		60		600		ns
Data set-up time	tsu_dat		0	10			ns
Data hold time	thd_dat		0	70			ns
Rising time of the SCLH signal	t <sub>R_CL</sub>		10	40	20 x 0.1C <sub>B</sub>	300	ns
Rising time of the SCLH signal after a repeated start command and an acknowledge bit	tF_CL1		10	80	20 х 0.1С <sub>в</sub>	300	ns
Falling time of the SCLH signal	t <sub>F_CL</sub>		10	40	20 х 0.1Св	300	ns
Rising time of the SDAH signal	t <sub>F_DA</sub>		10	80	20 х 0.1Св	300	ns
Falling time of the SDAH signal	t <sub>F_DA</sub>		10	80	20 x 0.1C <sub>B</sub>	300	ns
Set-up time for stop command	t <sub>SU_STO</sub>		160		600		ns
Bus free time between a stop and start command	t <sub>BUF</sub>		160		1300		ns
Data valid time	tvd_dat			16		90	ns
Data valid acknowledge time	tvd_ack			160		900	ns
Consoitive load for each		SDAH and SCLH line		100		400	pF
Capacitive load for each bus line	Св	SDAH + SDA line, SCLH + SCL line		400		400	pF

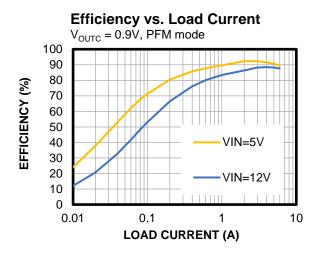
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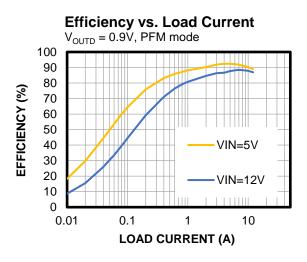
7) Guaranteed by design.

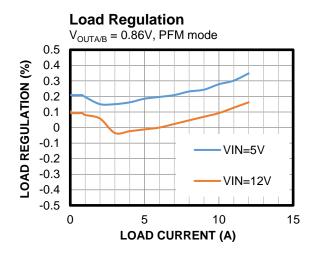


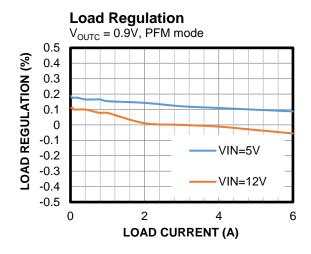
#### TYPICAL CHARACTERISTICS

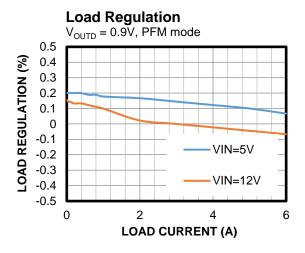






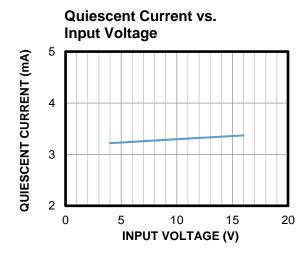






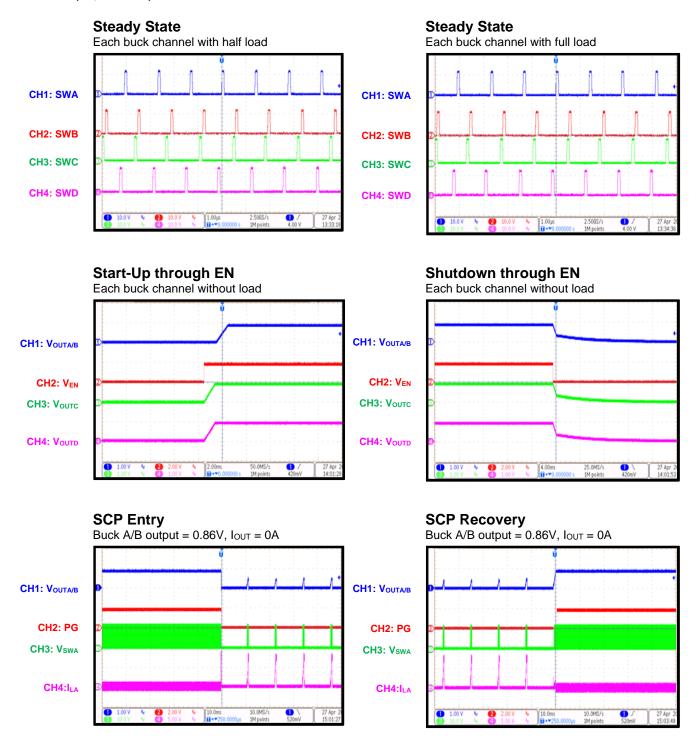


# TYPICAL CHARACTERISTICS (continued)



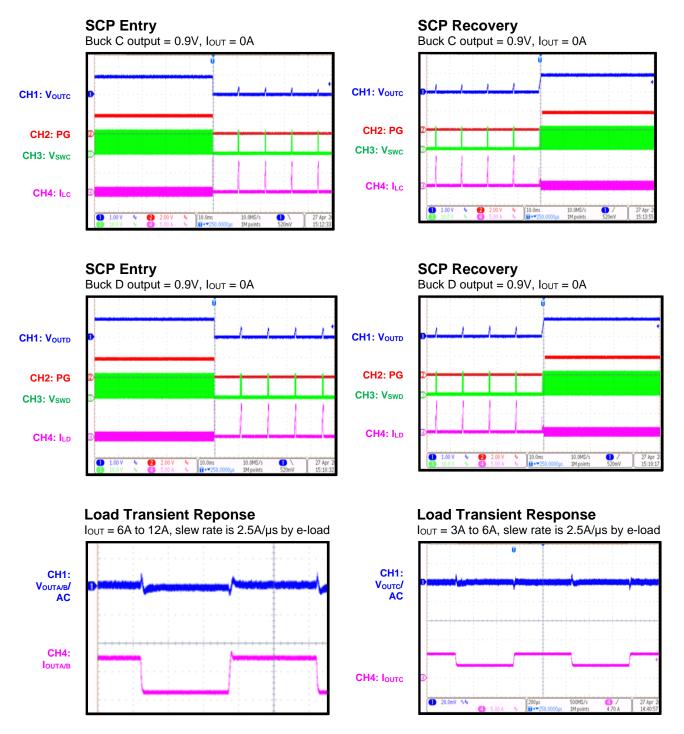


#### TYPICAL PERFORMANCE CHARACTERISTICS





## TYPICAL PERFORMANCE CHARACTERISTICS (continued)



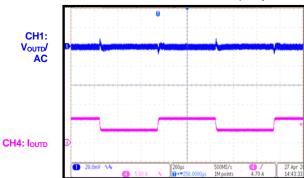


# **TYPICAL PERFORMANCE CHARACTERISTICS** (continued)

 $V_{IN} = 12V$ ,  $T_J = 25$ °C, unless otherwise noted.

#### **Load Transient Response**

Iout = 3A to 6A, slew rate is 2.5A/µs by e-load



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#### **FUNCTIONAL BLOCK DIAGRAM**

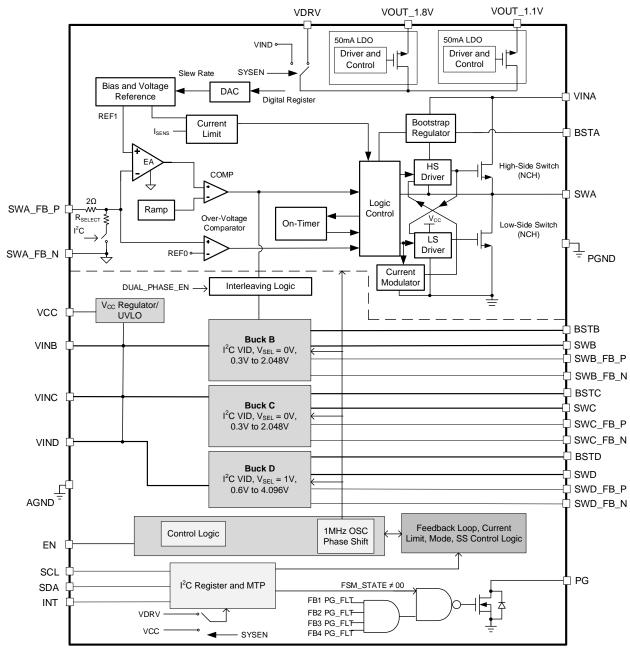


Figure 4: Functional Block Diagram

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#### **OPERATION**

#### **High-Efficiency Buck Converters**

Buck converter A (buck A), buck converter B (buck B), buck converter C (buck C), and buck converter D (buck D) are synchronous, stepdown DC/DC converters with built-in soft-start (SS), compensation, and current-limit protection with hiccup mode. Fixed-frequency constant-ontime (COT) control provides fast transient response. The switching clock is locked and phase-shifted from buck A to buck D in continuous conduction mode (CCM).

#### **POWER CONTROL**

#### **State Machine Diagram**

The state machine has a number of statuses, described below (see Figure 5).

#### No Supply

The MP5475's input pin has an under-voltage lockout (UVLO) detection circuit. If the input voltage ( $V_{INx}$ ) (where x = A, B, C, or D) and the VDRV voltage ( $V_{DRV}$ ), are below their respective UVLO rising thresholds, all the MP5475's functions are disabled.

#### Management State

After  $V_{DRV}$  exceeds its UVLO threshold, and before SYSEN is set, the MP5475 enters the management state. In the management state, the  $V_{INx}$  range is defined by  $V_{DRV}$ . The two low-dropout (LDO) regulator outputs, VOUT\_1.8V and VOUT\_1.1V, are enabled automatically when  $V_{DRV}$  reaches its UVLO rising threshold.

#### Power Off

If an over-temperature (OT) condition is triggered when  $V_{\text{IN}}$  exceeds its rising UVLO threshold, the MP5475 enters the power-off state. The MP5475 always monitors the power-on factor. If the power-on factor is detected after the MP5475's temperature drops below the falling threshold while in the power-off state, then the MP5475 enters the power-on sequence state.

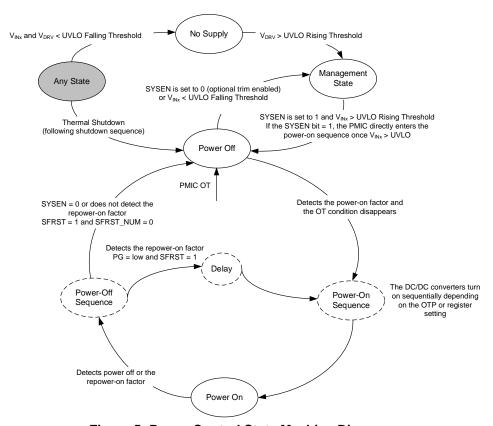


Figure 5: Power Control State Machine Diagram



# Power Supply and Under-Voltage Lockout (UVLO)

 $V_{\text{INA}}$  is the power supply for buck A;  $V_{\text{INB}}$  is the power supply for buck B;  $V_{\text{INC}}$  is the power supply for buck C;  $V_{\text{IND}}$  is the power supply for buck D. It is recommended to connect the VINA, VINB, VINC, and VIND pins together during application. When  $V_{\text{INx}}$  exceeds its UVLO rising threshold, the corresponding buck starts up. The buck shuts down when  $V_{\text{INx}}$  drops below the UVLO falling threshold. See Figure 5 on page 19 for more details regarding the power-on sequence state.

#### Power-On Sequence

The DC/DC converters turn on sequentially according to the pre-configured order set via the multiple-time programmable (MTP) memory.

#### Power On

The DC/DC converter turns on. In this state, the MP5475 is always monitoring the power-off factor or repower-on factor.

#### **Power-Off Sequence**

The MP5475 initiates the power-off sequence when it detects the power-off factor or repower-on factor in the power-on state. Set the SFRST bit to 1 when the PG pin goes low, then the DC/DC converters shut down sequentially following the power-off sequence. After the power-off sequence is completed, the PMIC automatically enters the power-on sequence after a timer delay.

Set the SFRST bit to 1 when PG is high, then wait until PG goes low for the DC/DC converters to shut down sequentially following the power-off sequence.

#### Shutdown Event

If the PMIC detects that both  $V_{\text{INx}}$  and  $V_{\text{DRV}}$  have fallen below their respective UVLO thresholds, the MP5475 changes to a no supply state, regardless of the current state.

#### **Power-On Factors**

After  $V_{\text{INx}}$  and  $V_{\text{DRV}}$  exceed their respective ULVO thresholds, apply a logic low-to-high

transition to the EN pin. The MP5475 has a few power-on factors, described below.

#### SYSEN

SYSEN is 1 data bit in the I<sup>2</sup>C register. If it is set to 1, the system changes from the power-off state to the power-on sequence. There are two ways to set SYSEN from 0 to 1:

- If the SYSEN bit is set to 1 via the MTP, the system automatically loads the SYSEN bit into the SYSEN I<sup>2</sup>C register when V<sub>INx</sub> crosses its UVLO threshold.
- After the MP5475 enters the management state, write the SYSEN bit to 1 via the I<sup>2</sup>C to enable the buck converter.

#### Thermal Protection Recovery

If the MP5475 is in a power-off state due to the die temperature exceeding the thermal protection threshold, then the MP5475 enters the power-on sequence automatically once the die temperature decreases.

#### **Power-On Sequence**

There are 8 slots for power-on sequence timing. All the converters can be configured to time slots 0 to 7 via the MTP. The delay time between each time slot is configured by the 3-bit register TS\_INTERVAL (see Table 1).

**Table 1: Slot Time Interval** 

TS_INTERVAL	Time Delay between Each Slot
000	10ms
001	5ms
010	2ms
011	1ms
100	500µs
101	200µs

Figure 6 on page 21 and Figure 7 on page 22 show the MP5475's power-on sequence when power is first applied. The platform may power up  $V_{\text{INx}}$  and  $V_{\text{DRV}}$  supplies in any sequence.

Figure 6 on page 21 shows  $V_{INx}$  supply ramping before the  $V_{DRV}$  supply.



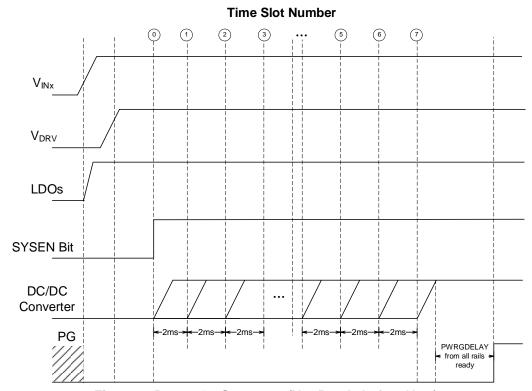


Figure 6: Power-On Sequence (VINx Ready before VDRV)

Figure 7 on page 22 shows the  $V_{DRV}$  supply ramping up before the  $V_{INx}$  supply. The PMIC does not mandate any specific timing relationship between the  $V_{INx}$  and  $V_{DRV}$  supplies.

Once either the  $V_{INx}$  or  $V_{DRV}$  supply is valid and stable, the MP5475 drives the LDO output supplies, VOUT\_1.8V and VOUT\_1.1V, to the load devices for LDO (SPD, TS, and RCD).

The PMIC has an automatic internal supply switch-over function from the  $V_{DRV}$  input supply

to the  $V_{INx}$  input supply. The input supply switch-over function is only applicable after the MP5475 has registered the SYSEN command. The MP5475 triggers the switch-over to the  $V_{INx}$  input supply when the  $V_{DRV}$  input drops below the 3V threshold. The internal input supply switch-over is for the MP5475's LDO outputs (VOUT\_1.8V and VOUT\_1.1V) and its I²C. The PMIC's I²C stays active when the MP5475 switches over to the  $V_{INx}$  input supply.



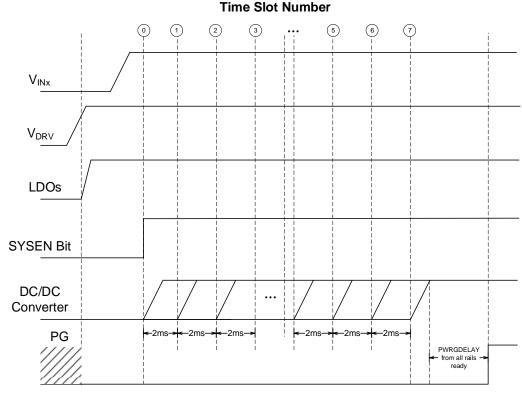


Figure 7: Power-On Sequence (VDRV Ready before VINx)

#### **Power-Off Factors**

# SYSEN – Software-Initiated Power Off (Trim Enable Function)

The MP5475 supports a software-controlled power off via the I<sup>2</sup>C interface. The SYSEN is 1 data bit in the I<sup>2</sup>C register. If the SYSEN bit is set to 0, the system enters a power-off sequence (trim enabled).

#### Thermal Protection Entry

If the MP5475's silicon die temperature exceeds the thermal protection threshold, the system enters a power-off state. In this scenario, the MP5475 enters the shutdown sequence instead of the power-off sequence and finally remains in the power-off state. For more details, see the Shutdown Sequence section on page 25.

#### V<sub>INx</sub> Under-Voltage Lockout (UVLO)

If the MP5475's  $V_{INx}$  falls below its UVLO falling threshold while  $V_{DRV}$  is still active, the system

enters a power-off state. In this scenario, the MP5475 enters the shutdown sequence instead of the power-off sequence and finally remains in the power-off state. For more details, see the Shutdown Sequence section on page 25.

# Power-Off Sequence (Enabled by the Trim SYSEN Off Function)

The PG pin pulls low before the DC/DC converter initiates shutdown. The converter's power-off sequence is determined by the shutdown delay registers (11h, 19h, 21h, and 29h).

Figure 8 on page 23 shows the power-off sequence via the SYSEN bit when  $V_{DRV}$  turns off before  $V_{INx}$ . Figure 9 on page 23 shows the power-off sequence via the SYSEN bit when  $V_{INx}$  turns off before  $V_{DRV}$ .



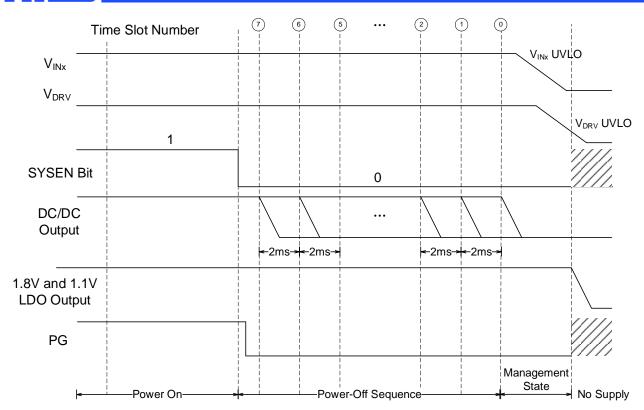


Figure 8: Power-Off Sequence via the SYSEN Bit (VINx Off before VDRV)

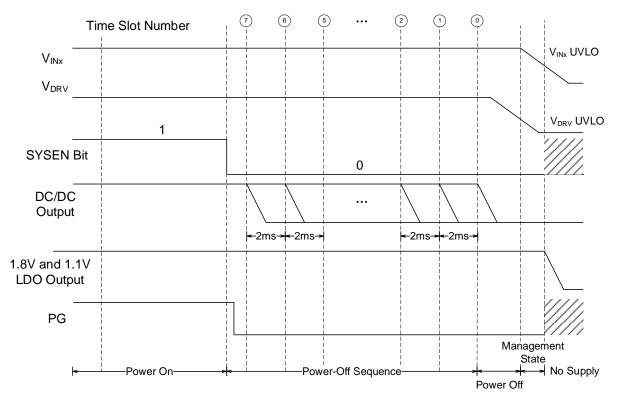


Figure 9: Power-Off Sequence via the SYSEN Bit (VDRV Off before VINX)



# Repower-On Factor Manual Reset (SFRST)

It is possible to manually reset the device with a software reset. If the SFRST bit is set to 1 via the I<sup>2</sup>C and the PG pin is low, the system detects this as a repower-on factor.

# Repower-On Sequence (Software-Initiated Power Cycle)

The MP5475 supports a software-controlled power reset via the I<sup>2</sup>C interface.

When using the software-controlled method, the SFRST bit is set high when the PG pin is low, The MP5475 waits for 200µs, then powers off the system. If the SFRST\_NUM bit is not set to 0 after the delay time (set via the OFF\_TIME register), then all the power rails power on again (see Figure 10).

When setting the SFRST bit high while PG is high, the MP5475 does not enter the repower-on sequence until PG goes low (see Figure 11).

After the repower-on sequence finishes, the SFRST\_NUM value is set by register 43h, bits[2:0] - 1. If SFRST\_NUM drops to 0 during the repower-on sequence, the MP5475 remains in the power-off state the next time a repower-on event occurs. There are two ways to restart the MP5475:

- Toggle V<sub>INx</sub> to below its UVLO threshold and ramp up.
- Configure SFRST\_NUM to a non-zero value.

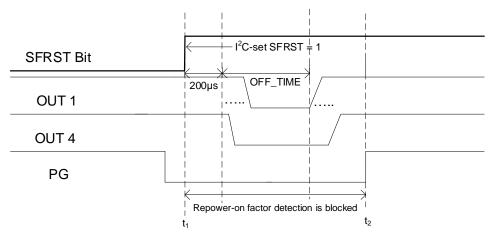


Figure 10: Repower-On Sequence (Set the SFRST Bit while PG Is Low)

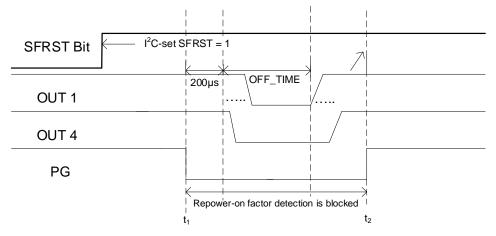


Figure 11: Repower-On Sequence (Set the SFRST Bit while PG Is High)



#### **Shutdown Sequence**

When V<sub>INx</sub> drops below its UVLO falling threshold or the MP5475 has an OT condition, the MP5475 enters the shutdown sequence directly, All the DC/DC converters turn off at the same time following the soft-stop ramping down slew rate (see Figure 12).

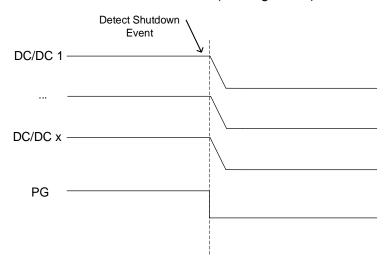


Figure 12: Shutdown Sequence

#### **Thermal Shutdown**

The MP5475 employs thermal shutdown by internally monitoring the IC's junction temperature (T<sub>J</sub>). If T<sub>J</sub> exceeds the 150°C threshold, the converter shuts off following the soft-stop ramping down slew rate. This is a nonlatch protection. There is a 20°C hysteresis. Once T<sub>J</sub> drops to about 130°C, the MP5475 initiates a soft start.

#### **Pre-Biased Start-Up**

The MP5475 is designed for monotonic start-up into pre-biased loads. If the output is pre-biased to a set voltage during start-up, the internal bootstrap (BST) voltage (V<sub>BST</sub>) is refreshed and charged, as well as the voltage on the internal soft-start capacitor (Css). If VBST exceeds its rising threshold and the C<sub>SS</sub> voltage exceeds the sensed output voltage  $(V_{OUTx})$  (where x = A, B, C, or D) at the FB pin, then the MP5475 starts to work normally.

#### Power Good (PG)

The MP5475 provides a power good (PG) output to indicate whether the enabled buck's V<sub>OUTx</sub> is ready. The PG pin is an open-drain output. Connect the PG pin to VCC or another voltage source through a pull-up resistor (e.g.  $10k\Omega$ ).

If the FB voltage  $(V_{FB})$  exceeds 92% of the reference voltage (V<sub>REF</sub>), the PG pin pulls high after a 500µs default time (or another MTPconfigured delay time). During normal operation. the PG pin pulls low when any enabled regulator falls below the UV threshold with a 50µs delay. The PG pin pulls low when all converters are disabled.

If UVLO occurs, SYSEN = 0, or overtemperature protection (OTP) occurs, then the PG pin pulls low immediately. If an over-current (OC) condition occurs, the PG pin pulls low when V<sub>FB</sub> drops below 87% of V<sub>REF</sub> after a 50µs delay.

#### **General Status Interrupt (INT)**

The MP5475 provides an interrupt control unit that is responsible for asserting and de-asserting the INT pin to the application host.

If the related interrupt is unmasked, it propagates to the INT pin. If the related interrupt is masked, the assertion of an interrupt from the masked register does not cause the IRQ signal to assert.

INT asserts low until all the interrupt events are removed. Figure 13 on page 26 shows the IRQ architecture block diagram.



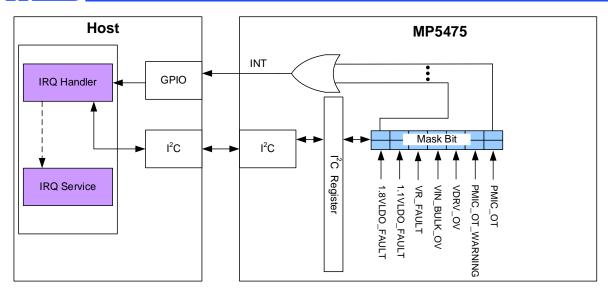


Figure 13: IRQ Architecture Block Diagram

#### **Output Over-Voltage Protection (OVP)**

The MP5475 monitors  $V_{\text{OUTx}}$  and enters overvoltage protection (OVP) discharge mode once V<sub>OUTx</sub> exceeds 122% of its regulation voltage for longer than 2µs. In OVP discharge mode, the low-side MOSFET (LS-FET) turns on and stays on until the LS-FET's current reaches the negative current limit. This discharges the output to keep V<sub>OUTx</sub> within its normal range. If the OV condition still exists, the LS-FET turns on again after a fixed delay to repeat the discharge behavior.

The MP5475 exits this discharge mode when V<sub>FB</sub> drops below 110% of V<sub>REF</sub>.

If the MP5475's  $V_{INx}$  exceeds the input OVP threshold by 14.5V during OVP discharge mode, then the MP5475 shuts down until V<sub>INx</sub> drops below 14.2V, after which the MP5475 restarts. Input OVP is only active when under an output OV condition.

OVP can be enabled or disabled via the I2C and MTP interface.

#### Input Over-Voltage Protection (OVP)

The MP5475 monitors V<sub>INx</sub> and enters OVP mode once V<sub>INx</sub> exceeds 16.6V. In OVP mode, the MP5475 cannot enter forced continuous conduction mode (FCCM), which means that there is no soft shutdown when the device shuts down.

The MP5475 exits this mode when V<sub>INx</sub> drops below 16V.

#### **Output Discharge**

To discharge the energy of the output capacitor (C<sub>OUT</sub>) during the power-off sequence or shutdown sequence, there are discharge paths both from the SWx and FBx pins to ground. The discharge function can be enabled or disabled via the I2C and MTP interface.

#### Soft Start (SS) and Soft Shutdown

The MP5475 employs a soft-start and soft shutdown mechanism to ensure a smooth output during start-up and shutdown.

When the MP5475 is enabled and V<sub>BST</sub> reaches its rising threshold, the internal digital-to-analog converter (DAC) outputs a ramp voltage (V<sub>REF</sub>). V<sub>OUTx</sub> smoothly ramps up with V<sub>REF</sub>. Once the DAC output reaches the final voltage, it maintains a steady voltage. At this point, soft start finishes, and the MP5475 enters steady state operation.

When the MP5475 is disabled, the internal DAC ramps down V<sub>REF</sub>. V<sub>OUTx</sub> follows the softshutdown slew rate with V<sub>REF</sub> until the output drops to 0.3V. Then soft shutdown stops and the MP5475's output is discharged by the FB pin's discharge FET, if the discharge function is enabled.

The start-up delay, shutdown delay, soft-start and soft-shutdown slew rate can be configured via the MTP.



#### **Out-of-Phase Operation**

Buck A, buck B, buck C, and buck D are frequency-locked and phase-shifted. Figure 14 shows the phase shift's default definition, which can also be changed via the MTP.

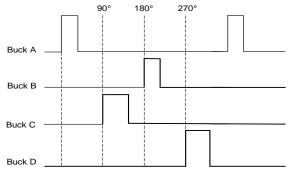


Figure 13: Phase-Shift Functional Diagram

#### Interleaving for Dual-Rail Mode

When interleaving mode is enabled, the MP5475's buck A/B and buck C/D operate with dual-phase interleaving (see Figure 14).

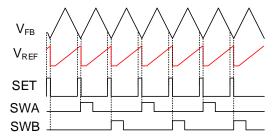


Figure 14: Interleaving for Dual-Rail Mode Diagram

The SET signal is triggered by comparing  $V_{FB}$  and  $V_{REF}$ . When the SET signal goes high, only one phase's pulse-width modulation (PWM) output becomes high; the next time SET goes high, the next phase's PWM output goes high. This achieves interleaving.

#### **Current Balancing**

When buck A and buck B work in dual-phase interleaving mode, the MP5475 senses two phase currents and auto-tunes buck A and buck B's on time ( $t_{ON}$ ) to achieve current balancing.

#### **Active Voltage Positioning (AVP)**

When buck A and buck B (or buck C and buck D) work in dual-phase interleaving mode, the MP5475 supports active voltage positioning (AVP) by setting the AVP\_EN bit to 1 via the I<sup>2</sup>C. An internal current-sense circuit generates the droop current (I<sub>DROOP</sub>) source, which is

proportional to the internal sensing current.  $I_{DROOP}$  is injected into the FB pin to produce the feedback (FB) voltage ( $V_{FBx}$ ) with a droop voltage.

#### **VCC** Regulator

A 3.5V internal regulator powers most of the internal circuitry. A decoupling capacitor is required to stabilize the regulator and reduce the ripple. This regulator takes the VINA input and operates across the full  $V_{\text{INA}}$  range.

# Over-Current Protection (OCP) and Short-Circuit Protection (SCP)

The MP5475 provides valley current limit control. While the LS-FET turns on, the inductor current ( $I_L$ ) is monitored. If the sensed  $I_L$  exceeds the valley current limit threshold, the device enters over-current protection (OCP) mode. The high-side MOSFET (HS-FET) cannot turn on until the valley current limit disappears. Meanwhile,  $V_{OUTx}$  drops until it falls below the under-voltage (UV) threshold.

If an UV and OC condition are both triggered, the MP5475 enters hiccup mode to periodically restart the related power rail. The hiccup duty cycle is very small to reduce the power dissipation during a short-circuit condition. During OCP, the device tries to recover from the OC fault with hiccup mode. That means that the chip disables the output power stage, discharges C<sub>SS</sub>, and then automatically tries to soft start again. If the OC condition still exists when soft start elapses, the device repeats this operation. OCP is a non-latch protection.

# Multiple-Time Programmable (MTP) Configuration

The I<sup>2</sup>C and MTP blocks are active once V<sub>DRV</sub> exceeds its UVLO rising threshold.

When  $V_{DRV}$  starts up the MP5475, the MTP data is loaded into the corresponding I<sup>2</sup>C registers during the first start-up, and the I<sup>2</sup>C registers directly control buck A to buck D's parameters. The I<sup>2</sup>C register and MTP table share the same register address.

After the MP5475's  $V_{DRV}$  and  $V_{INx}$  start up, the system-on-chip (SoC) configures the MP5475's  $I^2C$  register and MTP.

When the SoC writes to the I<sup>2</sup>C register, the I<sup>2</sup>C register takes effect immediately; this setting can also be burned into the MTP. During normal buck



operation, the I<sup>2</sup>C master can read and write to the register's data online.

#### Safety Considerations for Writing to the MTP

Several protection items can reduce the failure rate of MTP writing. Figure 15 shows how to configure the MTP, and follow the three steps below to write to the MTP registers:

- 1. Set MTP\_PROGRAM to 1. The I<sup>2</sup>C register is locked to prevent write operations until MTP configuring finishes, but the SoC can read the I<sup>2</sup>C register during this period.
- 2. The MP5475 checks the MTP's burning power supply. If this supply exceeds 5.1V, MTP writing continues; otherwise, abort and unlock the I<sup>2</sup>C write protection.
- 3. The MP5475 calculates the sum of all related I<sup>2</sup>C registers that are burnt into the MTP register, then generates 8-bit checksum data. The sum is not a true sum of all I<sup>2</sup>C registers. Rather, it is an arithmetic to combine all the data. The checksum result is written to the MTP register as well.

After MTP write operation finishes (typically after about 100ms), the MP5475 sets MTP\_PROGRAM to 0. I<sup>2</sup>C register write protection is unlocked. The MTP device configuration specification is up to 0.5mA/bit for 50ms. This means that two configuration cycles with less current requires about 100ms.

The SoC can read the register; if the MTP\_PROGRAM goes to 0, this indicates that the MTP configuration is done.

After MTP write operation finishes, the system SoC can read the MTP register data to confirm that the correct value is saved to the MTP registers. If anything is wrong, the SoC writes to the MTP again.

During  $V_{\text{IN}}$  start-up, before loading the MTP data into the I<sup>2</sup>C register, the MP5475 executes a checksum calculation for all related MTP registers, then compare this value with the checksum byte. If they match, then MTP data is loaded to the I<sup>2</sup>C register; Otherwise, the I<sup>2</sup>C register uses a hard-coded default value. An I<sup>2</sup>C/register flag bit is available to indicate whether this is a checksum error.

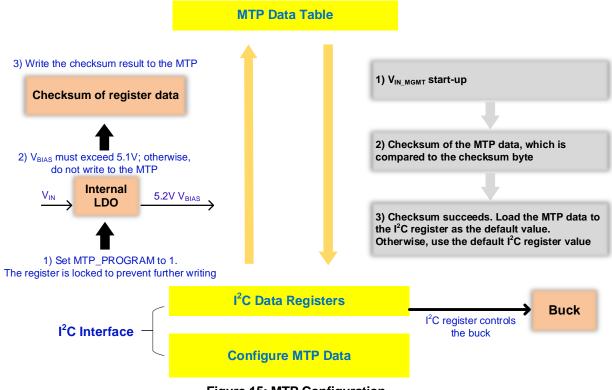


Figure 15: MTP Configuration



#### I<sup>2</sup>C INTERFACE

#### I<sup>2</sup>C Serial Interface

The I<sup>2</sup>C is a two-wire, bidirectional, serial interface consisting of a data line (SDA) and a clock line (SCL). The lines are pulled to a bus voltage externally when they are idle. When connecting to the line, a master device generates the SCL signal and device address, then arranges the communication sequence. The MP5475 interface is an I<sup>2</sup>C slave. The I<sup>2</sup>C adds flexibility to the power supply solution. Voutx, the transition slew rate, and other parameters can be controlled by the I<sup>2</sup>C instantaneously.

#### **Data Validity**

One clock pulse is generated for each data bit transferred. The data on the SDA line must be stable during the clock's high period. The high or low state of the data line can only change after the clock signal on the SCL line stays low for no shorter than maximum data hold time (thd\_DAT), and also no longer than the maximum data setup time (tsu\_DAT) before the next SCL clock starts (see Figure 16).

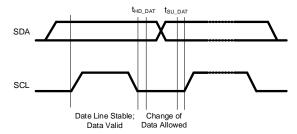


Figure 16: Bit Transfer on the I<sup>2</sup>C Bus

The start (S) and stop (P) commands are signaled by the master device, which signifies the beginning and the end of the I<sup>2</sup>C transfer. A start command is defined as the SDA signal transitioning from high to low while SCL is high. A stop command is defined as the SDA signal transitioning from low to high while SCL is high (see Figure 17).

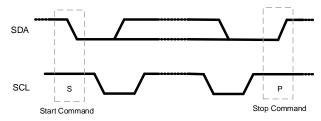


Figure 17: Start and Stop Commands

Start and stop commands are always generated by the master. The bus is busy after the start condition, and it is considered to be free again after the stop command. The bus remains busy if a repeated start (Sr) is generated instead of a stop command. The start and repeated start commands are functionally identical.

#### **Transfer Data**

Every byte put on the SDA line must be 8 bits long. Each byte has to be followed by an acknowledge (ACK) bit. The acknowledge-related clock pulse is generated by the master. The transmitter releases the SDA line (high) during the acknowledge clock pulse. The receiver must pull down the SDA line during the acknowledge clock pulse so that it remains stable low during the clock pulse's high period.

Figure 18 shows the data transfer format. After the start command, a slave address is sent. This address is 7 bits long, followed by an 8th data direction bit (R/W). A 0 indicates a transmission (write), and a 1 indicates a request for data (read). A data transfer is always terminated by a stop command, which is generated by the master. If the master still wants to communicate on the bus, it can generate a repeated start command and address another slave without first generating a stop command.

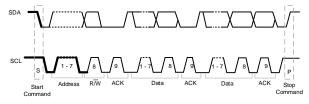


Figure 18: A Complete Data Transfer

Figure 19 on page 30 shows an I<sup>2</sup>C write example for a single register. Figure 20 on page 30 shows an I<sup>2</sup>C read example for a single register.



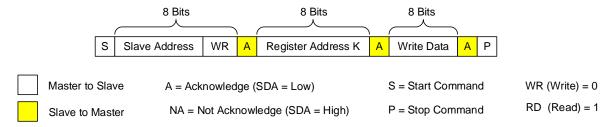


Figure 19: I<sup>2</sup>C Write Singe Register Example

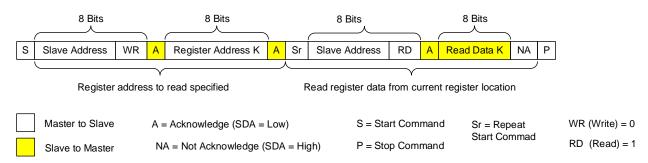


Figure 20: I<sup>2</sup>C Read Singe Register Example



## **REGISTER MAP**

#### MTP CONFIGURATION TABLE

Scope	REG (0x)	D[7]	D[6]	D[5]	D[4]	D[3]	D[2]	D[1]	D[0]	
	10 (WR)	DUAL_ PHASE_ ENA	SOFT	Γ_START_DEL/	AYA		SOFT_STA	ART_TIMEA		
	11 (WR)	SHU	JTDOWN_DELA	AYA	SOFT_ST	OP_TIMEA	VOUT_	_TRANSITION	_RATEA	
	12 (WR)	VOUT_ LIMIT_ENA	MODEA	CURRENT	_LIMITA	VOUT_ OVP_ENA		DELAY_ ECTA	VOUT_ DIS_ENA	
Buck	13 (WR)	VOUT_ SELECTA			RESERVED			V_REF	A_HIGH	
Α	14 (WR)				V_REF	A_LOW				
	15 (WR)				RESEI	RVED				
	16 (WR)				RESEI	RVED				
	17 (WR)	AVP_ENA	AVP_0	GAINA			AVP_TRIMA			
	18 (WR)	RESERVED	SOFT	_START_DEL/	AYB		SOFT_STA	ART_TIMEB		
	19 (WR)		JTDOWN_DELA	AYB	SOFT_ST	OP_TIMEB	VOUT_	_TRANSITION		
	1A (WR)	VOUT_ LIMIT_ENB	MODEB	CURRENT	_LIMITB	VOUT_ OVP_ENB		DELAY_ CTB	VOUT_ DIS_ENB	
Buck B	1B (WR)	VOUT_ SELECTB			RESERVED			V_REF	B_HIGH	
	1C (WR)				V_REFE	B_LOW				
	1D (WR)				RESEI	RVED				
	1E (WR)				RESEI	RVED				
	20 (WR)	DUAL_ PHASE_ ENC	SOFT	_START_DELA	AYC		SOFT_STA	ART_TIMEC		
	21 (WR)		TDOWN_DELA	YC	SOFT_ST	OP_TIMEC			TRANSITION_RATEC	
	22 (WR)	VOUT_ LIMIT_ENC	MODEC	CURRENT	_LIMITC	VOUT_ OVP_ENC	PHASE_ SELE	DELAY_ CTC	VOUT_ DIS_ENC	
Buck C	23 (WR)	VOUT_ SELECTC			RESERVED			V_REF	C_HIGH	
	24 (WR)				V_REFO	C_LOW				
	25 (WR)				RESEI	RVED				
	26 (WR)				RESEI	RVED				
	27 (WR)	AVP_ENC	AVP_C	SAINC			AVP_TRIMC			
	28 (WR)	RESERVED	SOFT	_START_DELA	AYD		SOFT_STA	ART_TIMED		
	29 (WR)		TDOWN_DELA	YD	SOFT_ST	OP_TIME4	_	TRANSITION		
Buck	2A (WR) 2B	VOUT_ LIMIT_END VOUT_	MODED	CURRENT	_LIMITD	VOUT_ OVP_END	PHASE_ SELE	DELAY_ CTD	VOUT_ DIS_END	
D	(WR) 2C	SELECTD	RESERVED V_REF						D_HIGH	
	(WR) 2D				V_REF	D_LOW				
	(WR) 2E				RESEI					
	(WR)				RESE	RVED				



# **REGISTER MAP** (continued)

#### MTP CONFIGURATION TABLE

Scope	REG (0x)	D[7]	D[6]	D[5]	D[4]	D[3]	D[2]	D[1]	D[0]	
	40 (WR)	SYSEN	RESERVED	ENA	ENB	ENC	END	RESERVED	SFRST	
	41 (WR)	RESERVED			I2C_	SLAVE_ADDR	ESS			
	42 (WR)	FREQ (500kHz/750kHz/1000kHz/1.25MHz/ 1.5MHz/2MHz)				TS_INTERVAL	PWRG_DELAY			
	43 (WR)	UVLO	MTP_ SHUTDOW PROGRAM DELAY_E		OFF_	_TIME	SFRST_NUM			
System	44 (WR)	RESERVED	RESE	RVED	WP_EN	RESERVED	RESERVED	PWR_GC	OOD_CFG	
	45 (WR)	RESERVED	1.8VLDO_ FAULT_MSK	1.1VLDO_ FAULT_MSK	VR_FAULT_ MSK	VBULK_OV_ MSK	VDRV_ OV_MSK	PMIC_ HIGH_ TEMP_ WARNING_ MSK	PMIC_ HIGH_ TEMP_ SHUTDOWN_ MSK	
	50 (WR)			MTP_CONFIGURE_CODE						
	51 (WR)				MTP_REVISIO	N_NUMBER				



#### MTP TABLE DESCRIPTION

#### DUAL\_PHASE\_EN1 and DUAL\_PHASE\_EN3 (from Registers 10h and 20h)

The DUAL\_PHASE\_ENx bits set whether buck A and buck B (or buck C and buck D) operate in dual-phase interleaving mode or in independent, single-phase mode.

Bits	Access	Bit Name	Default	Reset Condition	Description
7	WR	DUAL_PHASE_ ENA DUAL_PHASE_ ENC	DUAL_PHASE_ ENA = 1 DUAL_PHASE_ ENC = 0	V <sub>CC</sub> < 2V, V <sub>DRV</sub> < 2V	Sets whether buck A and buck B (or buck C and buck D) operate in dual-phase interleaving mode or in independent, single-phase mode. The dual-phase enable bit only takes effect in MTP.  0: Independent, single-phase operation 1: Dual-phase interleaving operation

#### SOFT\_START\_DELAYx and SOFT\_START\_TIMEx (from Registers 10h, 18h, 20h, and 28h)

The SOFT\_START\_DELAYx and SOFT\_START\_TIMEx (where x = A, B, C, and D) bits set the soft-start delay time and soft-start time for buck A, buck B, buck C, and buck D.

Bits	Access	Bit Name	Default	Reset Condition	Description
					Sets the time delay between when the input voltage (V <sub>INx</sub> ) exceeds UVLO threshold, the LDOs are ready, and SYSEN = high to when the related buck's output voltage starts to ramp up. There are 8 different values. For more details, see Figure 6 on page 21 and Figure 7 on page 22.
6:4	WR	SOFT_START_ DELAYx	00	Vcc < 2V, V <sub>DRV</sub> < 2V	000: Time slot 0 001: Time slot 1 010: Time slot 2 011: Time slot 3 100: Time slot 4 101: Time slot 5 110: Time slot 6 111: Time slot 7
3:0	WR	SOFT_START_ TIMEx	0111	V <sub>CC</sub> < 2V, V <sub>DRV</sub> < 2V	Sets the soft-start slew rate for each buck. The values below are the potential internal reference voltage (V <sub>REF</sub> ) slew rates. If the relevant VOUT_SELECT bit is set, the output voltage (V <sub>OUTx</sub> ) (where x = A, B, C, and D) slew rate is 2 times the value listed below.  0000: 8mV/µs 0001: 4mV/µs 0010: 2.7mV/µs 0011: 2mV/µs 0110: 1.6mV/µs 0101: 1.3mV/µs 0110: 1.14mV/µs 0111: 1mV/µs 1000: 0.89mV/µs 1001: 0.67mV/µs 1010: 0.5mV/µs 1110: 0.25mV/µs 1111: 0.167mV/µs



# SHUTDOWN\_DELAYx, SOFT\_STOP\_TIMEx, and VOUT\_TRANSITION\_RATEx (from Registers 11h, 19h, 21h, and 29h)

The SHUTDOWN\_DELAYx, SOFT\_STOP\_TIMEx, and VOUT\_TRANSITION\_RATEx (where x = A, B, C, or D) bits set the shutdown time, soft-stop time, and  $V_{OUTx}$  transition rate for buck A, buck B, buck C, and buck D.

Bits	Access	Bit Name	Default	Reset Condition	Description
					Sets the delay time to SYSEN = 0 or SFRST = 0 and the buck $V_{\text{OUTx}}$ starting to ramp down. The 3 bits can set 8 different values:
7:5	WR	SHUTDOWN_ DELAYx	00	V <sub>CC</sub> < 2V, V <sub>DRV</sub> < 2V	000: Time slot 0 001: Time slot 1 010: Time slot 2 011: Time slot 3 100: Time slot 4 101: Time slot 5 110: Time slot 6 111: Time slot 7
4:3	WR	SOFT_STOP_ TIMEx	10	Vcc < 2V, VdRV < 2V	Sets the soft-shutdown slew rate for each buck. The slew rates below are the internal $V_{REF}$ slew rates. If the relevant VOUT_SELECT bit is set, the soft-shutdown slew rate is 2 times the value listed below. 00: $4mV/\mu s$ 01: $2mV/\mu s$ 10: $1mV/\mu s$ 11: $0.5mV/\mu s$
2:0	WR	VOUT_ TRANSITION_ RATEX	011	Vcc < 2V, VdRV < 2V	Sets the Voutx transition slew rate for each buck. The value below is the internal VREF slew rate. If the relevant VOUT_SELECT bit is set, the Vout slew rate is 2 times the value listed below.  000: 1.6mV/µs 001: 1.3mV/µs 010: 1.14mV/µs 011: 1mV/µs 100: 0.89mV/µs 101: 0.67mV/µs 111: 0.4mV/µs

# VOUT\_LIMIT\_ENx, MODEX, CURRENT\_LIMITX, VOUT\_OVP\_ENx, PHASE\_DELAY\_SELECTx, and VOUT\_DIS\_ENx (from Registers 12h, 1Ah, 22h, 2Ah)

The VOUT\_LIMIT\_ENx, MODEX, CURRENT\_LIMITX, VOUT\_OVP\_ENx, PHASE\_DELAY\_SELECTx, and VOUT\_DIS\_ENx (where x = A, B, C, or D) bits set the pulse-width modulation (PWM) mode, maximum  $V_{\text{OUTx}}$ , current limit, phase delay, and enable other protection functions, such as over-voltage protection (OVP) and passive output discharge.

Bits	Access	Bit Name	Default	Reset Condition	Description
7	WR	VOUT_LIMIT_ENx	0	Vcc < 2V, V <sub>DRV</sub> < 2V	Limits the maximum V <sub>OUTx</sub> of each buck's rail.  0: The maximum V <sub>OUTx</sub> has no limit; the value depends on the I <sup>2</sup> C V <sub>OUTx</sub> setting maximum duty cycle or absolute voltage limit  1: The maximum V <sub>OUTx</sub> is limited to V <sub>REF</sub> x 1 if the relevant VOUT_SELECT bit = 1



6	WR	MODEx	0	V <sub>CC</sub> < 2V, V <sub>DRV</sub> < 2V	Select the mode between automatic pulse-frequency modulation (PFM)/PWM mode and forced PWM mode.  0: Automatic PFM/PWM mode 1: Forced PWM mode
5:4	WR	CURRENT_LIMITx	11	V <sub>CC</sub> < 2V, V <sub>DRV</sub> < 2V	Sets the current limit of each buck, with 15% accuracy.  00: 4A valley current limit for 3A output current (lout) applications  01: 5A valley current limit for 4A lout applications  10: 6A valley current limit for 5A lout applications  11: 7A valley current limit for 6A lout applications
3	WR	VOUT_OVP_ENx	1	Vcc < 2V, V <sub>DRV</sub> < 2V	Enables each buck's output OVP.  0: Disabled 1: Enabled
2:1	WR	PHASE_DELAY_ SELECTX	PHASE_DELAY_ SELECTA = 00 (fixed) PHASE_DELAY_ SELECTB = 10 PHASE_DELAY_ SELECTC = 01 PHASE_DELAY_ SELECTD = 11	Vcc < 2V, VDRV < 2V	Sets the phase delay for each buck. Buck A is fixed to 00.  00: 0° delay 01: 90° delay 10: 180° delay 11: 270° delay
0	WR	VOUT_DIS_ENx	1	Vcc < 2V, V <sub>DRV</sub> < 2V	Enables the passive discharge function. Soft shutdown finishes until the buck Voutx discharges to 0.3V. The passive discharge resistor is then connected to the buck Voutx to further discharge the buck Voutx. This bit also enables buck A to buck D's output passive discharge function.  0: Disabled 1: Enabled

# VOUT\_SELECTx and V\_REFx\_HIGH (from Registers 13h, 1Bh, 23h, and 2Bh)

The VOUT\_SELECTx and V\_REFx\_HIGHx (where x = A, B, C, or D) bits set the buck's  $V_{OUTx}$ , the internal feedback divider ratio, and the high bit to set the internal  $V_{REF}$ .

Bits	Access	Bit Name	Default	Reset Condition	Description
7	WR	VOUT_SELECTX	VOUT_ SELECTA = 0 VOUT_ SELECTB = 0 VOUT_ SELECTC = 0 VOUT_ SELECTD = 1	Vcc < 2V, V <sub>DRV</sub> < 2V	Sets the internal feedback divider ratio.  0: V <sub>FB</sub> is directly fed to the error amplifier; V <sub>FB</sub> is equal to V <sub>REF</sub> 1: V <sub>FB</sub> is divided by 2, then compared to V <sub>REF</sub> ; V <sub>FB</sub> is equal to 2 times of V <sub>REF</sub> , and is between 0.6V and 4.096V
6:2	RO	RESERVED	5'b000000	Vcc < 2V, V <sub>DRV</sub> < 2V	Reserved.



1:0	WR	V_REFx_HIGH	VREFA = 10 VREFB = 10 VREFC = 10 VREFD = 01	Vcc < 2V, VdRV < 2V	These high bits set the internal V <sub>REF</sub> . The MP5475 does not execute V <sub>REF</sub> until the V_REFx_LOW bits are configured. Configure V_REFx_HIGH first, then configure V_REFx_LOW.
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#### V\_REFx\_LOW (from Registers 14h, 1Ch, 24h, and 2Ch)

The V\_REFx\_LOW bits set the internal V<sub>REF</sub>.

Bits	Access	Bit Name	Default	Reset Condition	Description
					These low bits set the internal V <sub>REF</sub> between 300mV and 2.048V, with 2mV per step.
7:0	WR	V_REFx_LOW	VREFA = 00100110 VREFB = 00100110 VREFC = 00100110 VREFD = 11000010	10 = 10   V <sub>CC</sub> < 2V, V <sub>DRV</sub> < 2V   V <sub>DRV</sub> <	{V_REFx_HIGH, V_REFx_LOW} = 00_1001_0110: 300mV {V_REFx_HIGH, V_REFx_LOW} = 00_1001_0111: 302mV 
					{V_REFx_HIGH, V_REFx_LOW} = 11_1111_1111: 2.048V Others: 0mV
					Note that the MP5475 does not execute V <sub>REF</sub> until the V_REFx_LOW bits are configured. The user must configure V_REFx_HIGH first, then configure V_REFx_LOW.

#### SYSTEM (40h)

The SYSTEM command enables system settings, including the overall system, each buck regulator, and software restart.

Bits	Access	Bit Name	Default	Reset Condition	Description
7	WR	SYSEN	1'b0	Vcc < 2V, VDRV < 2V	Enables the system. When the MP5475 detects a power- on event, it sets this bit to 1. Then the power-on sequence starts. The DC/DC converters turn on sequentially according to the corresponding enable bit (e.g. ENA = 1 for buck A) and power-on delay (SOFT_START_DELAY1) setting.
					Set this bit from 1 to 0 to trigger the power-off sequence. Other I <sup>2</sup> C registers are not reset when the I <sup>2</sup> C-set SYSEN transitions from 1 to 0.
6	WR	RESERVED	1'b1	V <sub>CC</sub> < 2V, V <sub>DRV</sub> < 2V	Reserved.
5:2	WR	ENx	ENA = 1 ENB = 1 ENC = 1 END = 1	V <sub>CC</sub> <2V, V <sub>DRV</sub> < 2V	Enables each buck regulator.  1: Enabled 0: Disabled
0	WR	SFRST	1'b1	Vcc < 2V, V <sub>DRV</sub> < 2V	Enables software restart.  0: Software restart is disabled 1: Software restart is enabled. The MP5475 initiates a repower-on event when PG low is detected during the power-on state



# AVP\_ENx, AVP\_GAINx, and AVP\_TRIMx (from Registers 17h and 27h)

The AVP\_EN, AVP\_GAIN, and AVP\_TRIM bits configure active voltage positioning (AVP) for buck A and buck B (or buck C and buck D).

Bits	Access	Bit Name	Default	Reset Condition	Description
7	7 WR AVP_ENX AVP_ENA = 0 AVP_ENC = 0		V <sub>CC</sub> < 2V, V <sub>DRV</sub> < 2V	Enables buck A and buck C's AVP function.  0: The AVP function is disabled	
			AVP_ENC = 0		1: The AVP function is enabled
6:5	WR	AVP_GAINx	AVP_GAINA = 01 AVP_GAINC = 01	Vcc < 2V, V <sub>DRV</sub> < 2V	Sets the AVP gain.  00: 2.5mV/A  01: 2mV/A  10: 1mV/A  11: 0.5V/A
4:0	WR	AVP_TRIMx	AVP_TRIMA = 0_0000 AVP_TRIMC = 0_0000	Vcc < 2V, VDRV < 2V	Sets the DC offset voltage to the Voutx command value when AVP is enabled between -28mV and +28mV, with 2mV per step.  x_0000: 0mV 0_0001: 2mV 0_1111: 28mV 1_0001: -2mV 1_1111: -28mV

# I2C\_SLAVE\_ADDRESS (from Register 41h)

The I2C\_SLAVE\_ADDRESS bits configures the slave address.

Bits	Access	Bit Name	Default	Reset Condition	Description
6:0	WR	I2C_SLAVE_ ADDRESS	6'b1100 000	Vcc < 2V, V <sub>DRV</sub> < 2V	Sets the MP5475's I <sup>2</sup> C slave address.  Note that the I <sup>2</sup> C slave address bits only take effect in the multiple-time programmable (MTP) memory.

### FREQ, TS\_INTERVAL, and PWRG\_DELAY (from Register 42h)

The FREQ, TS\_INTERVAL, and PWRG\_DELAY bits configure the system setting, including frequency, TS\_INTERVAL, and PG delay time.

Bits	Access	Bit Name	Default	Reset Condition	Description
7:5	WR	FREQ	3'b010: 1000kHz	Vcc < 2V, V <sub>DRV</sub> < 2V	Sets the frequency of the buck regulator. The switching frequency (f <sub>SW</sub> ) of buck A to buck D remains constant.  000: 500kHz 001: 750kHz 010: 1000kHz 011: 1250kHz 100: 1500kHz 101: 2000kHz



4:2	WR	TS_INTERVAL	3'b011	Vcc < 2V, VDRV < 2V	Determines the delay time between each time slot during the start-up delay and shutdown delay.  000: 10ms 001: 5ms 010: 2ms 011: 1ms 100: 500µs 101: 200µs
1:0	WR	PWRG_DELAY	2'b01	Vcc < 2V, VdRV < 2V	Sets the PG delay timer after the MP5475's start-up delay finishes.  00: 0.5ms 01: 1ms 01: 10ms 10: 25ms

# UVLO, SHUTDOWN\_DELAY\_EN, OFF\_TIME, and SFRST\_NUM (from Register 43h)

The UVLO, SHUTDOWN\_DELAY\_EN, OFF\_TIME, and SFRST\_NUM bits configure the system, including  $V_{\text{IN}}$  under-voltage lockout (UVLO), shutdown delay enable, off time during the repower-on sequence for software restart, and the number of repower times for software restart.

Bits	Access	Bit Name	Default	Reset Condition	Description
					Sets the V <sub>IN</sub> UVLO threshold.
7	WR	UVLO	1'b0	V <sub>CC</sub> < 2V, V <sub>DRV</sub> < 2V	0: 3.7V rising UVLO threshold, and 3.48V falling UVLO threshold (default) 1: 2.85V rising UVLO threshold, and 2.6V falling UVLO threshold
					Note that the UVLO control bit only takes effect in the MTP.
5	WR	SHUTDOWN_ DELAY_EN	1'b1	Vcc < 2V, V <sub>DRV</sub> < 2V	The MP5475 offers two types of shutdown sequences when SYSEN = 0 or during software reset. The first type of shutdown sequence is where buck A to buck D follow the shutdown sequence. The second type of shutdown sequence is where the buck A to buck D shutdown sequences occur at the same time. For more details, see the SHUTDOWN_DELAYx bit configuration (from registers 11h, 19h, 21h, and 29h).  0: Shuts down at the same time 1: The shutdown sequence follows the SHUTDOWN_DELAYx bit configuration (from registers 11h, 19h, 21h, and 29h)
4:3	WR	OFF_TIME	2'b00	Vcc < 2V, V <sub>DRV</sub> < 2V	Sets the off time during repower sequence for software restart.  00: 10ms 01: 25ms 10: 50ms 11: 100ms



2:0	WR	SFRST_NUM	3'b111	Vcc < 2V, Vdrv < 2V    Vinx < UVLO	Sets the number of repower times for software restart.  111: Repowers when SFRST is set, and PG low is detected 110: Repower times set to 5 101: Repower times set to 4 100: Repower times set to 3 011: Repower times set to 2 010: Repower times set to 1 001: Repower times set to 0 000: Repower times set to 0
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### PWR\_GOOD\_CFG (from Register 44h)

The PWR\_GOOD\_CFG bits configure the mask bit for the PWR\_GOOD signal.

Bits	Access	Bit Name	Default	Reset Condition	Description	
1:0	WR	PWR_GOOD_ CFG	2'b00	V <sub>CC</sub> < 2V, V <sub>DRV</sub> < 2V	Sets the mask bit for the PWR_GOOD signal.  00: PWR_GOOD automatic mode  01: Reserved  10: Forces PWR_GOOD to 0  11: Forces PWR_GOOD to 1	

## XXX\_MSK (from Register 45h)

The XXX\_MSK bits (1.8VLDO\_FAULT\_MSK, 1.1VLDO\_FAULT\_MSK, VR\_FAULT\_MSK, VBULK\_OV\_MSK, VDRV\_OV\_MSK, PMIC\_HIGH\_TEMP\_WARNING\_MSK, or PMIC\_HIGH\_TEMP\_SHUTDOWN\_MSK) set the mask or unmask for the 1.8VLDO\_FAULT, 1.1VLDO\_FAULT, VR\_FAULT, VBULK\_OV, VDRV\_OV, PMIC\_HIGH\_TEMP\_WARNING, or PMIC\_HIGH\_TEMP\_SHUTDOWN signal.

Bits	Access	Bit Name	Default	Reset Condition	Description	
6:0	WR	XXX_MSK	6'b0000 00	V <sub>CC</sub> < 2V, V <sub>DRV</sub> < 2V	Sets the interrupt mask bit for the 1.8VLDO_FAULT, 1.1VLDO_FAULT, VR_FAULT, VBULK_OV, VDRV_OV, PMIC_HIGH_TEMP_WARNING, or PMIC_HIGH_TEMP_SHUTDOWN signal.  0: Unmask is off for the related interrupt 1: Masks the related interrupt	

### MTP\_CONFIGURE\_CODE (from Register 50h)

The MTP CONFIGURE CODE bits set the MTP configure code.

Bits	Access	Bit Name	Default	Reset Condition	Description	
7:0	WR	MTP_ CONFIGURE_ CODE	N/A	V <sub>CC</sub> < 2V, V <sub>DRV</sub> < 2V	Sets the MTP configure code, which is used to identify different MTP configurations.	

### MTP\_REVISION\_NUMBER (from Register 51h)

The MTP\_REVISION\_NUMBER bits set the MTP revision number.

Bits	Access	Bit Name	Default	Reset Condition	Description
7:0	WR	MTP_REVISION_ NUMBER	N/A	V <sub>CC</sub> < 2V, V <sub>DRV</sub> < 2V	Sets the MTP revision number, which is used to track multiple MTP revisions.



# I<sup>2</sup>C REGISTER MAP

Scope	Reg (0x)	D[7]	D[6]	D[5]	D[4]	D[3]	D[2]	D[1]	D[0]			
осоре	iteg (ux)	ניו	D[0]	ը[մ]	נייןט	<b>Մ</b> [3]	D[Z]	D[1]				
	05 (RO)		RESER	RVED		FSM_S	STATE	PMR_ GOOD	PMR_ GOOD_ RAW			
	06 (RO)	BUCKA_ PG_FILT	BUCKB_ PG_FILT	BUCKC_ PG_FILT	BUCKD_ PG_FILT	BUCKA_ PG_RAW	BUCKB_ PG_RAW	BUCKC_ PG_RAW	BUCKD_ PG_RAW			
System	07 (RC)	BUCKA_ UV	BUCKB_ UV	BUCKC_ UV	BUCKD_ UV	BUCKA_ OV	BUCKB_ OV	BUCKC_ OV	BUCKD_ OV			
	08 (RC)	BUCKA_ OC	BUCKB_ OC	BUCKC_ OC	BUCKD_ OC	BUCKA_ OC_ WARNING	BUCKB_ OC_ WARNING	BUCKC_ OC_ WARNING	BUCKD_ OC_ WARNING			
	09 (WC)	RESERVED	1.8VLDO_ FAULT	1.1VLDO_ FAULT	VR_ FAULT	VBULK_ OV	VDRV_OV	PMIC_ HIGH_ TEMP_ WARNING	PMIC_ HIGH_ TEMP_ SHUTDOWN			
	10 (WR)	DUAL_ PHASE_ ENA	SOFT	_START_DE	LAYA		SOFT_ST	ART_TIMEA				
	11 (WR)	SHU	TDOWN_DEL	AYA	SOFT_S	TOP_TIMEA	VOUT	_TRANSITION	I_RATEA			
Buck A	12 (WR)	VOUT_ LIMIT_ ENA	MODEA	CURREN	T_LIMITA	VOUT_ OVP_ENA		PHASE_DELAY_ V SELECTA DI				
Buck A	13 (WR)	VOUT_ SELECTA RESERVED V_REFA_HIGH							FA_HIGH			
	14 (WR)		V_REFA_LOW									
	15 (WR)	RESERVED										
	16 (WR)				RE	SERVED						
	17 (WR)	AVP_ENA	AVP_	GAINA			AVP_TRIM	A				
	18 (WR)	RESERVED	SOFT	_START_DEL	_AYB							
	19 (WR)		TDOWN_DEL	AYB	SOFT_S	STOP_TIMEB	VOUT	_TRANSITION	I_RATEB			
David D	1A (WR)	VOUT_ LIMIT_ ENB	MODEB	CURREN	T_LIMITB	VOUT_ OVP_ENB	PHASE_DELAY_ VOUT_ SELECTB DIS_ENB					
Buck B	1B (WR)	VOUT_ SELECTB			RESERVE	V_REFB_HIGH						
	1C (WR)				V_R	EFB_LOW						
	1D (WR)				RE	SERVED						
	1E (WR)				RE	SERVED						
	20 (WR)	DUAL_ PHASE_ ENC	SOFT	_START_DEI	_AYC		SOFT_ST/	ART_TIMEC				
	21 (WR)	SHUT	DOWN_DELA	YC	SOFT_S	TOP_TIMEC	VOUT	_TRANSITION	I_RATEC			
Buck C	22 (WR)	VOUT_ LIMIT_ ENC	MODEC	CURREN <sup>-</sup>	 Γ_LIMITC	VOUT_ OVP_ENC		_DELAY_ ECTC	VOUT_ DIS_ENC			
2 ask o	23 (WR)	VOUT_ SELECTC			RESERVI	ED	ED V_REFC_HIGH					
	24 (WR)				V_R	EFC_LOW						
	25 (WR)				RE	SERVED						
	26 (WR)				RE	SERVED	•					
	27 (WR)	AVP_ENC	AVP_0	GAINC			AVP_TRIM	С				



# I<sup>2</sup>C REGISTER MAP (continued)

Scope	Reg (0x)	D[7]	D[6]	D[5]	D[4]	D[3]	D[2]	D[1]	D[0]			
	28 (WR)	RESERVED	SOFT	_START_DELAY	D	SOFT_START_TIMED						
	29 (WR)	SH	UTDOWN_DEL/	AYD	SOFT_STOP_TIMED VOUT			TRANSITION_RATED				
	2A (WR)	VOUT_ LIMIT_ END	MODED	CURRENT_	LIMITD	VOUT_ OVP_END	PHASE_ SELE	_DELAY_ ECTD	VOUT_ DIS_ END			
Buck D	2B (WR)	VOUT_ SELECTD		V_REFD_	HIGH							
	2C (WR)				V_REFD	_LOW						
	2D (WR)		RESERVED									
	2E (WR)			RESERVED								
	40 (WR)	SYSEN	RESERVED	ENA	ENB	ENC	END	RESERVED	SFRST			
	41 (WR)	RESERVED			SL	SLAVE_ADDRESS						
	42 (WR)	(500k/75	FREQ 0k/1000k/1.25M/	/1.5M/2M)		TS_INTERVA	L	PWRG_D	ELAY			
	43 (WR)	UVLO	MTP_ PROGRAM	SHUTDOWN_ DELAY_EN	OFI	F_TIME	o,	SFRST_NUM				
	44 (WR)	RESERVED	RESE	ERVED	WP_EN	RESERVED	RESERVED	PWR_GOO	D_CFG			
System	45 (WR)	RESERVED	1.8VLDO_ FAULT_ MSK	1.1VLDO_ FAULT_ MSK	VR_ FAULT_ MSK	VBULK_ OV_MSK	VDRV_ OV_MSK	PMIC_ HIGH_ TEMP_ WARNING_ MSK	PMIC_ HIGH_ TEMP_ SHUTD OWN_ MSK			
	50 (WR)			M	TP_CONFIG	URE_CODE						
	51 (WR)			M	TP_REVISIO	N_NUMBER						
	52 (WR)			MTF	P_PROGRAM	I_PASSWORD						
	54 (WR)	RI	EVISION_ID_MA	JOR_STEPPING		RE	VISION_ID_MIN	OR_STEPPING				
	55 (WR)				VENDER_II	D_BYTE0						
	56 (WR)				VENDER_II	D_BYTE1						

### **Register Bits Description**

Most of the register bits share the same description as the MTP table. Only the description of different register bits are included below.

The I<sup>2</sup>C register's default value is determined by the MTP table.

All I<sup>2</sup>C registers are reset at the  $V_{CC}$  UVLO threshold,  $V_{IN}$  < UVLO, or the EN pin going low.

OTP does not reset via the I<sup>2</sup>C register.

The below I<sup>2</sup>C register bits can only take effect after MTP:

- 1. DUAL\_PHASE\_EN1 (bit[7] of register 10h)
- 2. DUAL\_PHASE\_EN3 (bit[7] of register 20h)
- 3. I<sup>2</sup>C slave address (bits[6:0] of register 41h)
- 4. UVLO (bit[7] of register 43h)



# FSM\_STATE, PWR\_GOOD, and PWR\_GOOD\_RAW (from Register 05h)

The FSM\_STATE, PWR\_GOOD, and PWR\_GOOD\_RAW bits control certain system configurations, including the state, PWR\_GOOD\_RAW signal, and the output for all the BUCK\_PG\_FILT states.

Bits	Access	Bit Name	Default	Description
3:2	RO	FSM_STATE	2'b00	00: Management state 01: Power-on state
1	RO	PWR_GOOD	1'b0	Sets the PWR_GOOD_RAW signal, which is filtered by the FSM_STATE signal. When PWR_GOOD_RAW is high and the MP5475 is not in management state, PWR_GOOD is high.  0: PWR_GOOD outputs low 1: PWR_GOOD outputs high
0	RO	PWR_GOOD_RAW	1'b0	Sets the output for all the BUCK_PG_FILT signals.  0: PWR_GOOD_RAW outputs low 1: PWR_GOOD_RAW outputs high

### BUCKx\_PG\_FILT and BUCKx\_PG\_RAW (from Register 06h)

The BUCKx\_PG\_FILT and BUCKx\_PG\_RAW bits set each buck's PG output and the filter's PG output.

Bits	Access	Bit Name	Default	Description
7:4	RO	BUCKx_PG_FILT	4'b1111	Sets buck x's (where x = A, B, C, or D) PG output filter when working with the EN signal.  0: The filter's PG output is low (the selected rail's output is out of ±20% nominal output)  1: The filter's PG output is high (the selected rail's output is out of ±20% nominal output, or the rail is disabled)
3:0	RO	BUCKx_PG_RAW	4'b0000	Sets buck x's (where x = A, B, C, or D) raw PG output.  0: The PG raw output is low (the selected rail's output is out of ±20% nominal output)  1: The PG raw output is high (the selected rail output is within ±20% nominal output)

### BUCKx\_UV and BUCKx\_OV (from Register 07h)

The BUCKx\_UV and BUCKx\_OV bits indicate each buck's over-voltage (OV) or under-voltage (UV) status.

Bits	Access	Bit Name	Default	Description
7:4	RC	BUCKx_UV	4'b0000	Indicates buck x's (where x = A, B, C, or D) output UV status.  0: No UV condition on buck x  1: UV condition on buck x (below 20% of nominal output window)
3:0	RC	BUCKx_OV	4'b0000	Indicates buck x's (where x = A, B, C, or D) output OV status.  0: No OV condition on buck x  1: OV condition on buck x (above 20% of nominal output window)

#### BUCKx\_OC and BUCKx\_OC\_WARNING (from Register 08h)

The BUCKx\_OC and BUCKx\_OC\_WARNING bits indicate each buck's over-current (OC) status as well as the high current consumption warning status.

Bits	Access	Bit Name	Default	Description
7:4	RC	BUCKx_OC	4'b0000	Indicates buck x's (where x = A, B, C, or D) OC status.  0: No buck x OC condition  1: Buck x over-current protection (OCP) has occurred



3:0	RC	BUCKx_OC_ WARNING	4 50000	Indicates buck x's (where x = A, B, C, or D) high current consumption warning status (the output current exceeds 85% of the threshold).  0: No high current consumption warning 1: High current consumption warning
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# SYSTEM (09h)

The SYSTEM command indicates error statuses, such as 1.8V LDO and 1.1V LDO faults, voltage regulator (VR) faults, and  $V_{INx}$  OV faults, as well as PMIC high-temperature warnings and high-temperature shutdown, where the temperature is between 125°C and 150°C.

Bits	Access	Bit Name	Default	Description
				Indicates the 1.8VLDO's output PG status.
6	WC	1.8VLDO_FAULT	1'b0	0: The 1.8VLDO output is within ±15% of the nominal output window 1: The 1.8VLDO output is not within ±15% of the nominal output window
				Indicates the 1.1VLDO's output PG status.
5	wc	1.1VLDOX_FAULT	1'b0	0: The 1.1VLDO output is within ±15% of the nominal output window 1: The 1.1VLDO output is not within ±15% of the nominal output window
				Indicates the overall buck's PG status.
4	WC	VR_FAULT	1'b0	0: All buck outputs are within ±20% of the nominal range 1: One (or more) buck output(s) are outside of the ±20% nominal range
				Indicates the V <sub>INx</sub> OV status.
3	WC	VBULK_OV	1'b0	0: V <sub>INx</sub> is below 14.2V 1: V <sub>INx</sub> exceeds 14.5V
				Indicates V <sub>DRV</sub> 's OV status.
2	WC	VDRV_OV	1'b0	0: V <sub>DRV</sub> is below 3.5V 1: V <sub>DRV</sub> exceeds 3.6V
		DMIC HIGH TEMP		Indicates whether the PMIC has a high-temperature warning.
1	WC	PMIC_HIGH_TEMP_ WARNNING	1'b0	0: No high-temperature warning 1: The PMIC's silicon temperature exceeds 125°C
		DMIC HIGH TEMP		Indicates the PMIC's high-temperature shutdown status.
0	WC	PMIC_HIGH_TEMP_ SHUTDOWN	1'b0	0: No high temperature shutdown 1: The PMIC's silicon temperature exceeds 150°C

# MTP\_PROGRAM (from Register 43h)

The MTP\_PROGRAM bits control MTP configuration.

Bits	Access	Bit Name	Default	Reset Condition	Description
6	WR	MTP_PROGRAM	1'b0	Automatic	Controls MTP configuration.  Once this bit is set, the I <sup>2</sup> C register is written to the MTP table. During MTP writing, I <sup>2</sup> C write operation is locked and not acknowledged (NACK), but read operation is not locked until MTP write operation finishes. Then the system automatically resets this bit.



## WP\_EN (from Register 44h)

The WP\_EN bit enables I<sup>2</sup>C write protection.

Bits	Access	Bit Name	Default	Reset Condition	Description
4	WR	WP_EN	1'b0	V <sub>CC</sub> < 2V, V <sub>DRV</sub> < 2V	Enables I <sup>2</sup> C write protection.  0: No write protection 1: Only allowed to write to the I <sup>2</sup> C register while in the management state

# MTP\_PROGRAM\_PASSWORD( from Register 52h)

The MTP\_PROGRAM\_PASSWORD bits set the correct password for MTP configuration.

Bits	Access	Bit Name	Default	Reset Condition	Description
7:0	WR	MTP_ PROGRAM_ PASSWORD	8'b0000	V <sub>CC</sub> < 2V, V <sub>DRV</sub> < 2V	Sets the correct password for MTP configuration. These bits controls access to the MTP_PROGRAM bit.

### REVISION\_ID\_MAJOR\_STEPPING and REVISION\_ID\_MINOR\_STEPPING (from Register 54h)

The REVISION\_ID\_MAJOR\_STEPPING and REVISION\_ID\_MINOR\_STEPPING bits set the major and minor revision.

Bits	Access	Bit Name	Default	Reset Condition	Description
7:4	WR	REVISION_ID_ MAJOR_ STEPPING	4'b0000	Vcc < 2V, VdRV < 2V	Sets the major revision. All other encodings are reserved.  0000: Reserved 0001: Revision 1 0010: Revision 2 0011: Revision 3
3:0	WR	REVISION_ID_ MINOR_ STEPPING	4'b0000	V <sub>CC</sub> < 2V, V <sub>DRV</sub> < 2V	Sets the minor revision. All other encodings are reserved.  0000: Reserved 0001: Revision 1 0010: Revision 2 0011: Revision 3

### VENDOR\_ID\_BYTE0 (from Register 55h)

The VENDOR\_ID\_BYTE0 bits set the lower byte of the vendor's ID.

Bits	Access	Bit Name	Default	Reset Condition	Description
7:0	WR	VENDOR_ID_ BYTE0	8'b0000 0000	$V_{CC} < 2V$ , $V_{DRV} < 2V$	Sets the lower byte of the vendor's ID.

### VENDOR\_ID\_BYTE1 (from Register 56h)

The VENDOR\_ID\_BYTE1 bits set the higher byte of the vendor's ID.

Bits	Access	Bit Name	Default	Reset Condition	Description
7:0	WR	VENDOR_ID_ BYTE1	8'b0000 0000	V <sub>CC</sub> < 2V, V <sub>DRV</sub> < 2V	Sets the higher byte of the vendor's ID.



### APPLICATION INFORMATION

#### Selecting the Inductor

---- MPL

Optimized Performance with MPS Inductor MPL4020 Series

Choose a 0.22µH to 2µH inductor with a minimum DC current rating exceeding 25% of the maximum load current for most applications. To optimize efficiency, use an inductor with a DC resistance below  $15m\Omega$ . For most designs, the inductance (L1) can be calculated with Equation (1):

$$L1 = \frac{V_{OUT} \times (V_{IN} - V_{OUT})}{V_{IN} \times \Delta I_{I} \times f_{OSC}}$$
(1)

Where  $\Delta I_{l}$  is the inductor ripple current.

Choose the inductor ripple current to be approximately 30% of the maximum load current. The maximum inductor peak current (I<sub>L MAX</sub>) can be estimated with Equation (2):

$$I_{L_{\_MAX}} = I_{LOAD} + \frac{\Delta I_{L}}{2}$$
 (2)

Use a larger-value inductor to achieve improved efficiency under light-load conditions (below 100mA).

MPS inductors are optimized and tested for use with our complete line of integrated circuits.

Table 2 shows the MPS power inductor recommendations, where the part number can be selected based on the design requirements.

Table 2: Selecting the Power Inductor

Part Number	Inductance	Manufacturer	
MPL-AL4020-R47	0.47µH	MPS	
MPL-AL4020-R68	0.68µH	MPS	
MPL-AL4020-1R0	1µH	MPS	
MPL-AL4020-1R5	1.5µH	MPS	

For more information, visit the Inductors page on the MPS website.

### **Selecting the Input Capacitor**

The step-down converter has a discontinuous input current, and requires a capacitor to supply the AC current to the converter while maintaining the DC V<sub>IN</sub>. Use low-ESR capacitors for the best performance. Ceramic capacitors with X5R or X7R dielectrics are recommended for the best results due to their low ESR and small

temperature coefficients. For most applications, a 22µF capacitor is sufficient.

Since C1 absorbs the input switching current, it requires an adequate ripple current rating. The RMS current in the input capacitor (C<sub>IN</sub>) (I<sub>C1</sub>) can be calculated with Equation (3):

$$I_{C1} = I_{LOAD} \times \sqrt{\frac{V_{OUT}}{V_{IN}}} \times \left(1 - \frac{V_{OUT}}{V_{IN}}\right)$$
 (3)

The worst-case condition occurs at  $V_{IN} = 2 \times V_{OUT}$ , which can be estimated with Equation (4):

$$I_{C1} = \frac{I_{LOAD}}{2} \tag{4}$$

For simplification, choose C<sub>IN</sub> with an RMS current rating that is greater than half of the maximum load current.

C<sub>IN</sub> can be electrolytic, tantalum, or ceramic. When using electrolytic or tantalum capacitors, add a small, high-quality ceramic capacitor (e.g. 0.1µF) placed as close to the IC as possible. When using ceramic capacitors, ensure there is enough capacitance to provide sufficient charge to prevent an excessive voltage ripple at the input. The input voltage ripple ( $\Delta V_{IN}$ ) caused by the capacitance can be calculated with Equation (5):

$$\Delta V_{IN} = \frac{I_{LOAD}}{f_{SW} \times C1} \times \frac{V_{OUT}}{V_{IN}} \times \left(1 - \frac{V_{OUT}}{V_{IN}}\right)$$
 (5)

# Selecting the Output Capacitor for the Step-**Down Regulator**

The output capacitor  $(C_{\text{OUT}})$  for the step-down converter maintains the DC V<sub>OUT</sub>. Use ceramic, tantalum, or low-ESR electrolytic capacitors. For the best results, use low-ESR capacitors to keep the output voltage ripple low. The output voltage ripple ( $\Delta V_{OUT}$ ) can be estimated with Equation (6):

$$\Delta V_{\text{OUT}} = \frac{V_{\text{OUT}}}{f_{\text{SW}} \times L_{1}} \times \left(1 - \frac{V_{\text{OUT}}}{V_{\text{IN}}}\right) \times \left(R_{\text{ESR}} + \frac{1}{8 \times f_{\text{SW}} \times C2}\right) \tag{6}$$

Where L1 is the inductance, and R<sub>ESR</sub> is the equivalent series resistance (ESR) of C<sub>OUT</sub>.

For ceramic capacitors, the capacitance dominates the impedance at f<sub>SW</sub> and causes the majority of  $\Delta V_{OUT}$ .



For simplification,  $\Delta V_{\text{OUT}}$  can be calculated with Equation (7):

$$\Delta V_{OUT} = \frac{V_{OUT}}{8 \times f_{SW}^2 \times L1 \times C2} \times \left(1 - \frac{V_{OUT}}{V_{IN}}\right)$$
 (7)

For tantalum or electrolytic capacitors, the ESR dominates the impedance at  $f_{SW}$ . For simplification,  $\Delta V_{OUT}$  can be estimated with Equation (8):

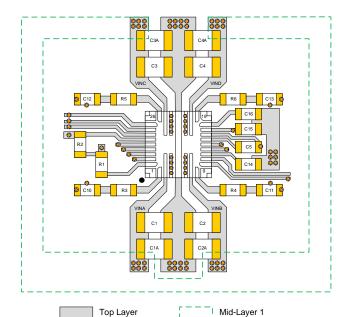
$$\Delta V_{\text{OUT}} = \frac{V_{\text{OUT}}}{f_{\text{SW}} \times L1} \times \left(1 - \frac{V_{\text{OUT}}}{V_{\text{IN}}}\right) \times R_{\text{ESR}}$$
 (8)

The  $C_{\text{OUT}}$  characteristics also affect the stability of the regulation system.

#### **PCB Layout Guidelines**

Efficient PCB layout is critical for stable operation. For the best results, refer to Figure 21 and follow the guidelines below:

- 1. Connect the input ground to the ground with the shortest and widest trace possible.
- 2. Connect  $C_{IN}$  to the VINx pin (where x = A, B, C, or D) with the shortest and widest trace possible.
- 3. Ensure all FB connections are short and direct.
- 4. Place the FB resistors and compensation components as close to the chip as possible.
- 5. Route the SWx pin (where x = A, B, C, or D) away from sensitive analog areas, such as FB.
- 6. Place the VCC decoupling capacitor close to the VCC and AGND pins.
- 7. Keep an open space around the PMIC and ensure that the airflow is at least 200FPM to 400FPM on the PMIC surface and the other side of the DIMM board. Airflow is required for PMIC heat dissipation.



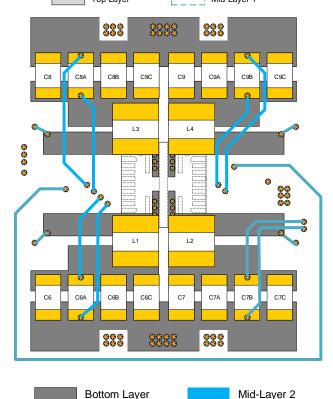


Figure 21: Recommended PCB Layout



# TYPICAL APPLICATION CIRCUITS

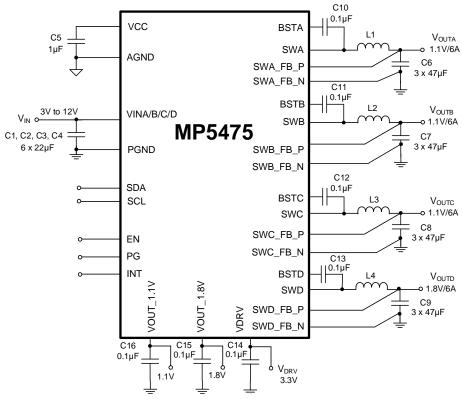


Figure 22: Typical Application Circuit (Buck A and Buck B in Single-Phase Regulator Mode)



# **TYPICAL APPLICATION CIRCUITS (continued)**

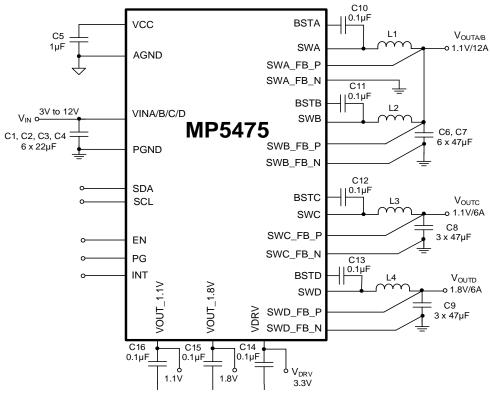


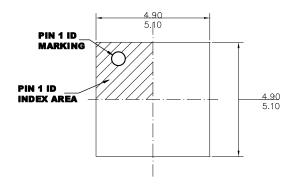
Figure 23: Typical Application (Buck A and Buck B in Dual-Phase Regulator Mode)

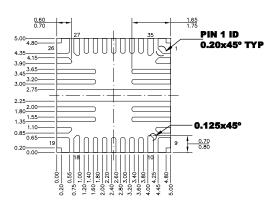
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# **PACKAGE INFORMATION**

# **QFN-35 (5mmx5mm)**



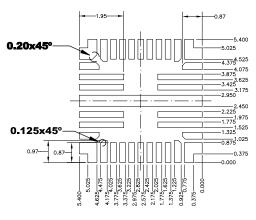


#### **TOP VIEW**



#### **BOTTOM VIEW**

#### **SIDE VIEW**



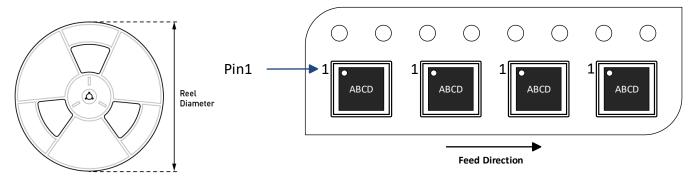
#### **RECOMMENDED LAND PATTERN**

#### **NOTE:**

- 1)ALL DIMENSIONS ARE IN MILLIMETERS. 2) LEAD COPLANARITY SHALL BE 0.08 MILLIMETERS MAX.
- 3) JEDEC REFERENCE IS MO-333.
- 4) DRAWING IS NOT TO SCALE.



# **CARRIER INFORMATION**



Part Number	Package	Quantity/	Quantity/	Quantity/	Reel	Carrier	Carrier
	Description	Reel	Tube	Tray	Diameter	Tape Width	Tape Pitch
MP5475GU- xxxx-Z	QFN-35 (5mmx5mm)	5000	N/A	N/A	13in	12mm	8mm



# **REVISION HISTORY**

Revision #	Revision Date	Description	Pages Updated
1.0	3/7/2024	Initial Release	-

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